

### FEATURES

- 3 V to 5.5 V supply operation
- 50 MHz serial interface
- 10 MHz multiplying bandwidth
- 2.5 MSPS update rate
- INL of  $\pm 1$  LSB for 12-bit DAC
- $\pm 10$  V reference input
- Low glitch energy  $< 2$  nV-s
- Extended temperature range  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- 10-lead MSOP package
- Pin-compatible 8-, 10-, and 12-bit current output DACs
- Guaranteed monotonic
- 4-quadrant multiplication
- Power-on reset with brownout detection
- Daisy-chain mode
- Readback function
- 0.4  $\mu\text{A}$  typical power consumption

### APPLICATIONS

- Portable battery-powered applications
- Waveform generators
- Analog processing
- Instrumentation
- Programmable amplifiers and attenuators
- Digitally controlled calibration
- Programmable filters and oscillators
- Composite video
- Ultrasound
- Gain, offset, and voltage trimming

### GENERAL DESCRIPTION

The AD5426/AD5432/AD5443<sup>1</sup> are CMOS 8-, 10-, and 12-bit current output digital-to-analog converters (DACs), respectively. These devices operate from a 3 V to 5.5 V power supply, making them suitable for battery-powered applications and many other applications.

These DACs use a double buffered, 3-wire serial interface that is compatible with SPI®, QSPI™, MICROWIRE™, and most DSP interface standards. In addition, a serial data out pin (SDO) allows for daisy-chaining when multiple packages are used. Data readback allows the user to read the contents of the DAC register via the SDO pin. On power-up, the internal shift register and latches are filled with 0s and the DAC outputs are at zero scale.

As a result of manufacturing on a CMOS submicron process, the parts offer excellent 4-quadrant multiplication characteristics with large signal multiplying bandwidths of 10 MHz. The applied external reference input voltage,  $V_{\text{REF}}$ , determines the full-scale output current. An integrated feedback resistor,  $R_{\text{FB}}$ , provides temperature tracking and full-scale voltage output when combined with an external current to voltage precision amplifier.

The AD5426/AD5432/AD5443 DACs are available in small, 10-lead MSOP packages.

<sup>1</sup> U.S. Patent No. 5,689,257

### FUNCTIONAL BLOCK DIAGRAM

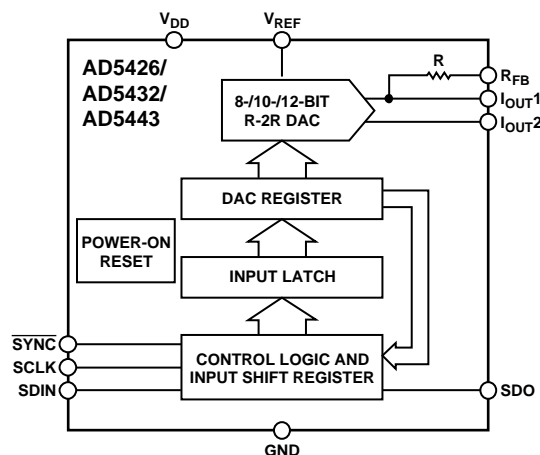


Figure 1.

### Rev. A

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## TABLE OF CONTENTS

|   |    |   |    |
|---|----|---|----|
| Specifications.....                                     | 3  | Reference Selection .....   | 18 |
| Timing Characteristics.....                             | 5  | Amplifier Selection .....   | 18 |
| Absolute Maximum Ratings.....                           | 6  | Serial Interface .....  | 20 |
| ESD Caution.....  | 6  | Microprocessor Interface .....  | 21 |
| Pin Configuration and Function Descriptions.....        | 7  | PCB Layout and Power Supply Decoupling.....                           | 23 |
| Typical Performance Characteristics .....               | 8  | Evaluation Board for the AD5426/AD5432/AD5443 Series of<br>DACs ..... | 23 |
| Terminology .....                                       | 14 | Operating the Evaluation Board .....                                  | 23 |
| Theory of Operation .....                               | 15 | Overview of AD54xx and AD55xx Devices .....                           | 27 |
| Circuit Operation .....                                 | 15 | Outline Dimensions .....  | 28 |
| Single-Supply Applications .....                        | 17 | Ordering Guide .....  | 28 |
| Positive Output Voltage .....                           | 17 |   |    |
| Adding Gain.....  | 17 |   |    |
| DACs Used as a Divider or Programmable Gain Element ... | 18 |   |    |

## REVISION HISTORY

### 5/05—Rev. 0 to Rev. A

|  |           |
|--|-----------|
| Updated Format.....                                | Universal |
| Changes to Specifications .....                    | 3         |
| Changes to Figure 42.....                          | 16        |
| Change to Figure 45 .....                          | 17        |
| Change to Figure 46 .....                          | 18        |
| Changes to Table 7, Table 8, and Table 9 .....     | 19        |
| Additions to Microprocessor Interface Section..... | 21        |

### 2/04—Revision 0: Initial Version

## SPECIFICATIONS

$V_{DD} = 2.5\text{ V to }5.5\text{ V}$ ,  $V_{REF} = 10\text{ V}$ ,  $I_{OUT2} = 0\text{ V}$ ; temperature range for Y version:  $-40^{\circ}\text{C to }+125^{\circ}\text{C}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted; dc performance measured with OP177; ac performance with AD8038, unless otherwise noted.

Table 1.

| Parameter                                       | Min                   | Typ | Max   | Unit       | Conditions   |
|---|-----------------------|-----|-------|------------|--|
| STATIC PERFORMANCE                              |                       |     |       |            |  |
| AD5426  |                       |     |       |            |  |
| Resolution                                      |                       |     | 8     | Bits       | Guaranteed monotonic   |
| Relative Accuracy                               |                       |     | ±0.25 | LSB        |  |
| Differential Nonlinearity                       |                       |     | ±0.5  | LSB        |  |
| AD5432  |                       |     |       |            |  |
| Resolution                                      |                       |     | 10    | Bits       | Guaranteed monotonic   |
| Relative Accuracy                               |                       |     | ±0.5  | LSB        |  |
| Differential Nonlinearity                       |                       |     | ±1    | LSB        |  |
| AD5443  |                       |     |       |            |  |
| Resolution                                      |                       |     | 12    | Bits       | Guaranteed monotonic   |
| Relative Accuracy                               |                       |     | ±1    | LSB        |  |
| Differential Nonlinearity                       |                       |     | −1/+2 | LSB        |  |
| Gain Error                                      |                       |     | ±10   | mV         |  |
| Gain Error Temperature Coefficient <sup>1</sup> |                       | ±5  |       | ppm FSR/°C |  |
| Output Leakage Current                          |                       |     | ±10   | nA         | Data = 0x0000, T <sub>A</sub> = 25°C, I <sub>OUT1</sub>  |
|   |                       |     | ±20   | nA         | Data = 0x0000, T = −40°C to 125°C, I <sub>OUT1</sub>   |
| REFERENCE INPUT <sup>1</sup>                    |                       |     |       |            |  |
| Reference Input Range                           |                       | ±10 |       | V          |  |
| V <sub>REF</sub> Input Resistance               | 8                     | 10  | 12    | kΩ         | Input resistance TC = −50 ppm/°C   |
| R <sub>FB</sub> Resistance                      | 8                     | 10  | 12    | kΩ         | Input resistance TC = −50 ppm/°C   |
| Input Capacitance                               |                       |     |       |            |  |
| Code Zero Scale                                 |                       | 3   | 6     | pF         |  |
| Code Full Scale                                 |                       | 5   | 8     | pF         |  |
| DIGITAL INPUT/OUTPUT <sup>1</sup>               |                       |     |       |            |  |
| Input High Voltage, V <sub>IH</sub>             | 1.7                   |     |       | V          | V <sub>DD</sub> = 4.5 V to 5 V, I <sub>SOURCE</sub> = 200 μA<br>V <sub>DD</sub> = 2.5 V to 3.6 V, I <sub>SOURCE</sub> = 200 μA<br>V <sub>DD</sub> = 4.5 V to 5 V, I <sub>SINK</sub> = 200 μA<br>V <sub>DD</sub> = 2.5 V to 3.6 V, I <sub>SINK</sub> = 200 μA |
| Input Low Voltage, V <sub>IL</sub>              |                       |     | 0.6   | V          |  |
| Output High Voltage, V <sub>OH</sub>            | V <sub>DD</sub> − 1   |     |       | V          |  |
|   | V <sub>DD</sub> − 0.5 |     |       | V          |  |
| Output Low Voltage, V <sub>OL</sub>             |                       |     | 0.4   | V          |  |
|   |                       |     | 0.4   | V          |  |
| Input Leakage Current, I <sub>IL</sub>          |                       |     | 1     | μA         |  |
| Input Capacitance                               |                       | 4   | 10    | pF         |  |
| DYNAMIC PERFORMANCE <sup>1</sup>                |                       |     |       |            |  |
| Reference Multiplying Bandwidth                 |                       | 10  |       | MHz        | V <sub>REF</sub> = ±3.5 V; DAC loaded all 1s   |
| Output Voltage Settling Time                    |                       |     |       |            | V <sub>REF</sub> = 10 V; R <sub>LOAD</sub> = 100 Ω, DAC latch alternately loaded with 0s and 1s  |
| Measured to ±16 mV of FS                        |                       | 50  | 100   | ns         |  |
| Measured to ±4 mV of FS                         |                       | 55  | 110   | ns         |  |
| Measured to ±1 mV of FS                         |                       | 90  | 160   | ns         |  |
| Digital Delay                                   |                       | 40  | 75    | ns         | Interface delay time   |
| 10% to 90% Rise/Fall Time                       |                       | 15  | 30    | ns         | Rise and fall time, V <sub>REF</sub> = 10 V, R <sub>LOAD</sub> = 100 Ω   |
| Digital-to-Analog Glitch Impulse                |                       | 2   |       | nV-s       | 1 LSB change around major carry, V <sub>REF</sub> = 0 V  |
| Multiplying Feedthrough Error                   |                       |     |       |            | DAC latch loaded with all 0s, V <sub>REF</sub> = ±3.5  |
|   |                       | 70  |       | dB         | 1 MHz  |
|   |                       | 48  |       | dB         | 10 MHz   |

# AD5426/AD5432/AD5443

| Parameter                             | Min | Typ | Max   | Unit            | Conditions   |
|---------------------------------------|-----|-----|-------|-----------------|--|
| Output Capacitance                    |     |     |       |                 |  |
| $I_{OUT1}$                            |     | 12  | 17    | pF              | All 0s loaded  |
|                                       |     | 10  | 12    | pF              | All 1s loaded  |
| $I_{OUT2}$                            |     | 22  | 25    | pF              | All 0s loaded  |
|                                       |     | 10  | 12    | pF              | All 1s loaded  |
| Digital Feedthrough                   |     | 0.1 |       | nV-s            | Feedthrough to DAC output with $\overline{SYNC}$ high and alternate loading of all 0s and all 1s |
| Analog THD                            |     | 81  |       | dB              | $V_{REF} = 3.5$ V p-p, all 1s loaded, $f = 1$ kHz  |
| Digital THD                           |     |     |       |                 | Clock = 1 MHz, $V_{REF} = 3.5$ V, $C_{COMP} = 1.8$ pF  |
| 50 kHz $f_{OUT}$                      |     | 73  |       | dB              |  |
| 20 kHz $f_{OUT}$                      |     | 74  |       | dB              |  |
| Output Noise Spectral Density         |     | 25  |       | nV/ $\sqrt{Hz}$ | @ 1 kHz  |
| SFDR Performance (Wide Band)          |     |     |       |                 | Clock = 1 MHz, $V_{REF} = 3.5$ V   |
| 50 kHz $f_{OUT}$                      |     | 75  |       | dB              |  |
| 20 kHz $f_{OUT}$                      |     | 76  |       | dB              |  |
| SFDR Performance (Narrow Band)        |     |     |       |                 | Clock = 1 MHz, $V_{REF} = 3.5$ V   |
| 50 kHz $f_{OUT}$                      |     | 87  |       | dB              |  |
| 20 kHz $f_{OUT}$                      |     | 87  |       | dB              |  |
| Intermodulation Distortion            |     | 78  |       | dB              | Clock = 1 MHz, $f_1 = 20$ kHz, $f_2 = 25$ kHz, $V_{REF} = 3.5$ V                                 |
| POWER REQUIREMENTS                    |     |     |       |                 |  |
| Power Supply Range                    | 3.0 |     | 5.5   | V               |  |
| $I_{DD}$                              |     |     | 0.6   | $\mu A$         | $T_A = 25^\circ C$ , logic inputs = 0 V or $V_{DD}$  |
|                                       |     | 0.4 | 5     | $\mu A$         | $T = -40^\circ C$ to $+125^\circ C$ , logic inputs = 0 V or $V_{DD}$                             |
| Power Supply Sensitivity <sup>1</sup> |     |     | 0.001 | %/%             | $\Delta V_{DD} = \pm 5\%$  |

<sup>1</sup> Guaranteed by design and characterization, not subject to production testing.

## TIMING CHARACTERISTICS

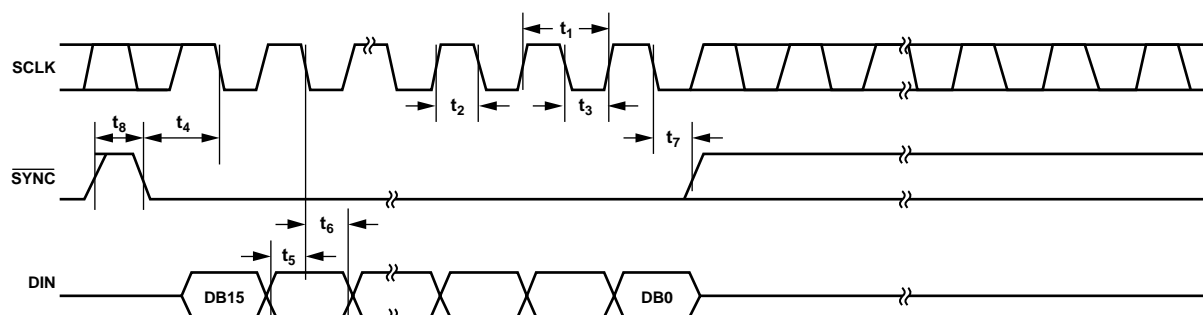
All input signals are specified with  $t_r = t_f = 1$  ns (10% to 90% of  $V_{DD}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH})/2$ .  $V_{DD} = 2.5$  V to 5.5 V,  $V_{REF} = 10$  V,  $I_{OUT2} = 0$  V; temperature range for Y version:  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 2.

| Parameter  | 2.5 V to 5.5 V | 4.5 V to 5.5 V | Unit    | Conditions/Comments   |
|------------|----------------|----------------|---------|---|
| $f_{SCLK}$ | 50             | 50             | MHz max | Max clock frequency   |
| $t_1$      | 20             | 20             | ns min  | SCLK cycle time   |
| $t_2$      | 8              | 8              | ns min  | SCLK high time  |
| $t_3$      | 8              | 8              | ns min  | SCLK low time   |
| $t_4^1$    | 13             | 13             | ns min  | $\overline{SYNC}$ falling edge to SCLK active edge setup time |
| $t_5$      | 5              | 5              | ns min  | Data setup time   |
| $t_6$      | 3              | 3              | ns min  | Data hold time  |
| $t_7$      | 5              | 5              | ns min  | $\overline{SYNC}$ rising edge to SCLK active edge             |
| $t_8$      | 30             | 30             | ns min  | Minimum $\overline{SYNC}$ high time                           |
| $t_9^2$    | 80             | 45             | ns typ  | SCLK active edge to SDO valid                                 |
|            | 120            | 65             | ns max  |   |

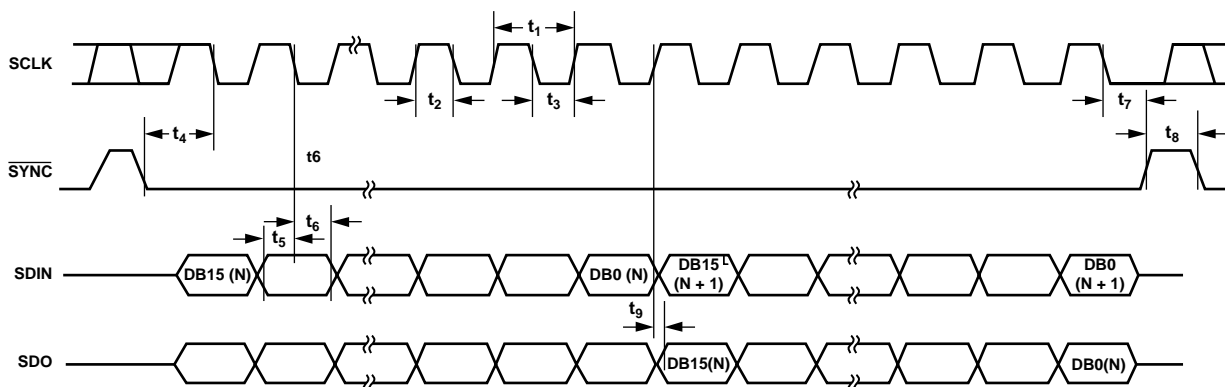
<sup>1</sup> Falling or rising edge as determined by control bits of serial word.

<sup>2</sup> Daisy-chain and readback modes cannot operate at maximum clock frequency. SDO timing specifications measured with load circuit, as shown in Figure 4.



ALTERNATIVELY, DATA MAY BE CLOCKED INTO INPUT SHIFT REGISTER ON RISING EDGE OF SCLK AS DETERMINED BY CONTROL BITS. TIMING AS PER ABOVE, WITH SCLK INVERTED.

Figure 2. Standalone Mode Timing Diagram



ALTERNATIVELY, DATA MAY BE CLOCKED INTO INPUT SHIFT REGISTER ON RISING EDGE OF SCLK AS DETERMINED BY CONTROL BITS. IN THIS CASE, DATA WOULD BE CLOCKED OUT OF SDO ON FALLING EDGE OF SCLK. TIMING AS PER ABOVE, WITH SCLK INVERTED.

Figure 3. Daisy-Chain and Readback Modes Timing Diagram

## ABSOLUTE MAXIMUM RATINGS

Transient currents of up to 100 mA do not cause SCR latch-up.  
 $T_A = 25^\circ\text{C}$ , unless otherwise noted.

**Table 3.**

| Parameter                                    | Rating                     |
|--|----------------------------|
| $V_{DD}$ to GND                              | −0.3 V to +7 V             |
| $V_{REF}$ , $R_{FB}$ to GND                  | −12 V to +12 V             |
| $I_{OUT1}$ , $I_{OUT2}$ to GND               | −0.3 V to $V_{DD} + 0.3$ V |
| Logic Inputs and Output <sup>1</sup>         | −0.3 V to $V_{DD} + 0.3$ V |
| Operating Temperature Range                  |                            |
| Extended Industrial (Y Version)              | −40°C to +125°C            |
| Storage Temperature Range                    | −65°C to +150°C            |
| Junction Temperature                         | 150°C                      |
| 10-lead MSOP $\theta_{JA}$ Thermal Impedance | 206°C/W                    |
| Lead Temperature, Soldering<br>(10 seconds)  | 300°C                      |
| IR Reflow, Peak Temperature<br>(<20 seconds) | 235°C                      |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

<sup>1</sup> Overvoltages at SCLK,  $\overline{\text{SYNC}}$ , and DIN are clamped by internal diodes.

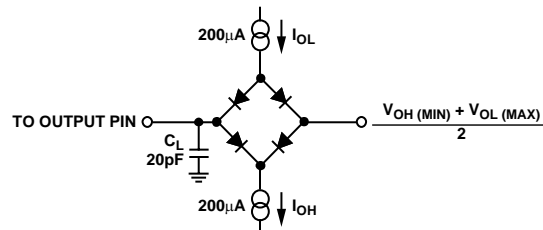


Figure 4. Load Circuit for SDO Timing Specifications

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

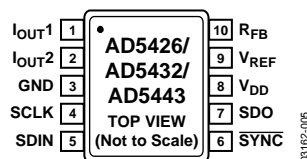


Figure 5. Pin Configuration

Table 4. Pin Function Descriptions

| Pin No. | Mnemonic                 | Function  |
|---------|--------------------------|---|
| 1       | I <sub>OUT1</sub>        | DAC Current Output.   |
| 2       | I <sub>OUT2</sub>        | DAC Analog Ground. This pin should normally be tied to the analog ground of the system.   |
| 3       | GND                      | Digital Ground Pin.   |
| 4       | SCLK                     | Serial Clock Input. By default, data is clocked into the input shift register on the falling edge of the serial clock input. Alternatively, by means of the serial control bits, the device may be configured such that data is clocked into the shift register on the rising edge of SCLK. The device can accommodate clock rates up to 50 MHz.  |
| 5       | SDIN                     | Serial Data Input. Data is clocked into the 16-bit input register on the active edge of the serial clock input. By default, on power-up, data is clocked into the shift register on the falling edge of SCLK. The control bits allow the user to change the active edge to rising edge.   |
| 6       | $\overline{\text{SYNC}}$ | Active Low Control Input. This is the frame synchronization signal for the input data. When $\overline{\text{SYNC}}$ goes low, it powers on the SCLK and DIN buffers, and the input shift register is enabled. Data is loaded to the mode, the serial interface counts clocks, and data is latched to the shift register on the 16th active clock edge.   |
| 7       | SDO                      | Serial Data Output. This allows a number of parts to be daisy-chained. By default, data is clocked into the shift register on the falling edge and out via SDO on the rising edge of SCLK. Data is always clocked out on the alternate edge to loading data to the shift register. Writing the readback control word to the shift register makes the DAC register contents available for readback on the SDO pin, clocked out on the opposite edges to the active clock edge. |
| 8       | V <sub>DD</sub>          | Positive Power Supply Input. These parts can be operated from a supply of 3 V to 5.5 V.   |
| 9       | V <sub>REF</sub>         | DAC Reference Voltage Input.  |
| 10      | R <sub>FB</sub>          | DAC Feedback Resistor Pin. Establish voltage output for the DAC by connecting to external amplifier output.   |

## TYPICAL PERFORMANCE CHARACTERISTICS

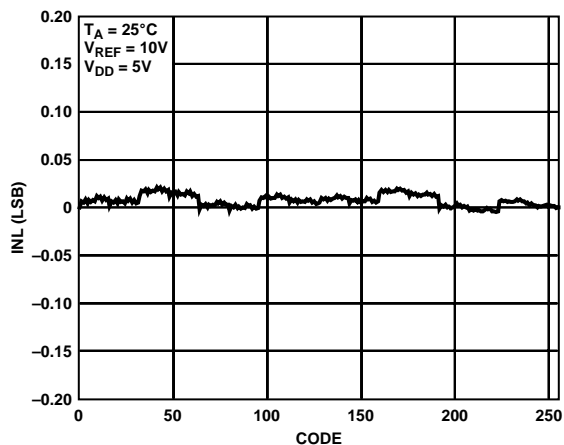


Figure 6. INL vs. Code (8-Bit DAC)

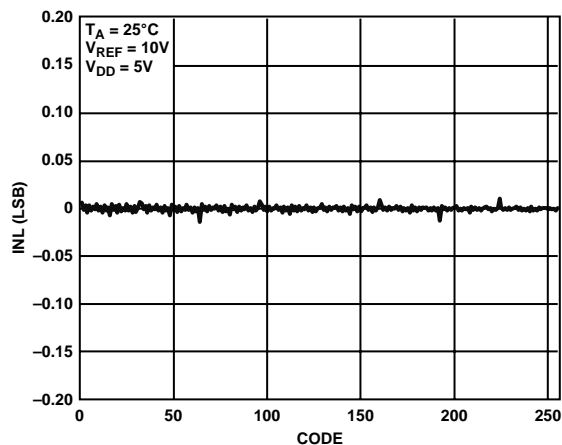


Figure 9. DNL vs. Code (8-Bit DAC)

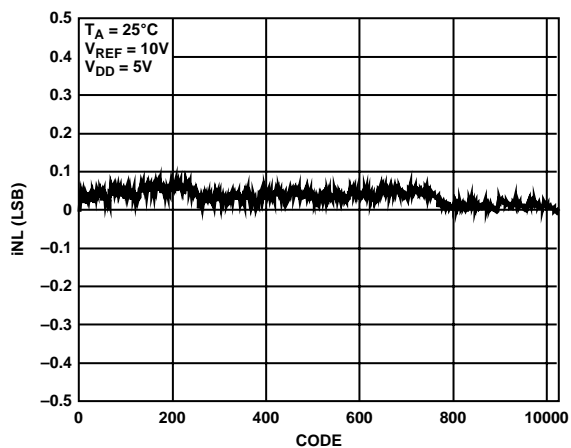


Figure 7. INL vs. Code (10-Bit DAC)

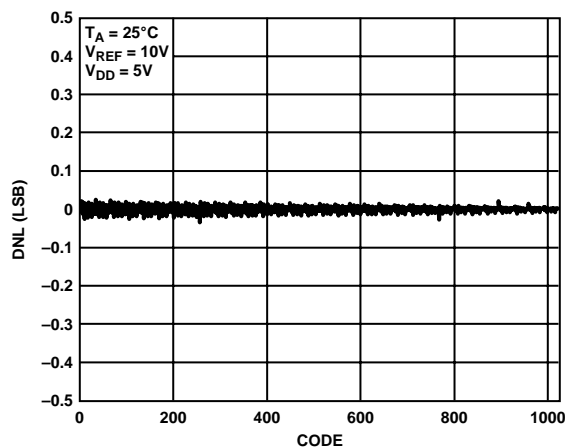


Figure 10. DNL vs. Code (10-Bit DAC)

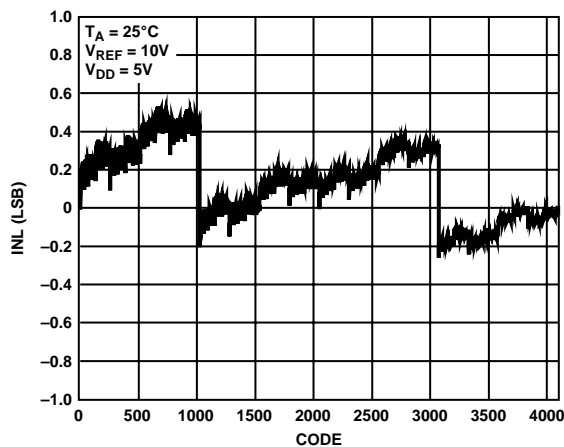


Figure 8. INL vs. Code (12-Bit DAC)

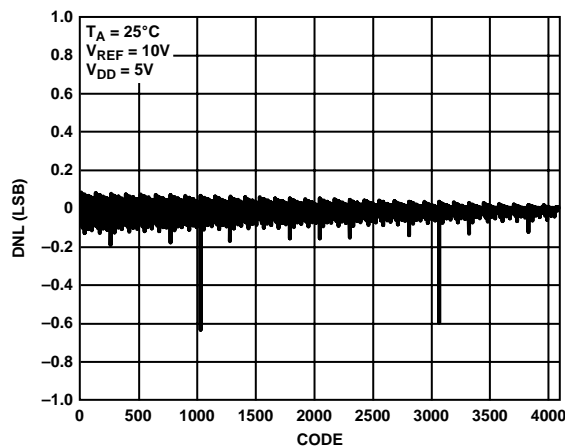


Figure 11. DNL vs. Code (12-Bit DAC)



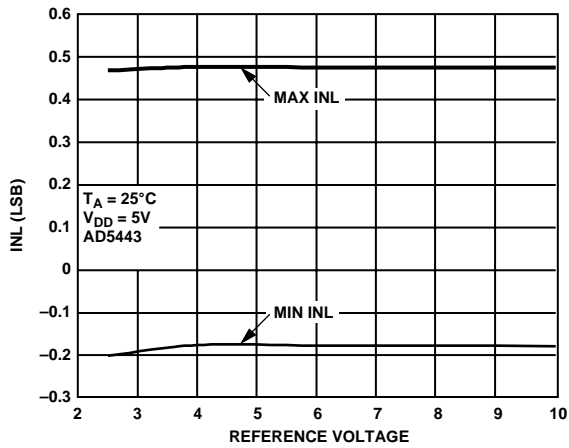


Figure 12. INL vs. Reference Voltage

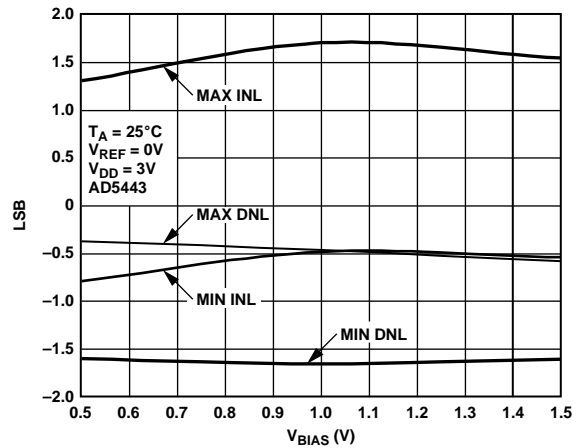


Figure 15. Linearity vs.  $V_{BIAS}$  Voltage Applied to  $I_{OUT2}$

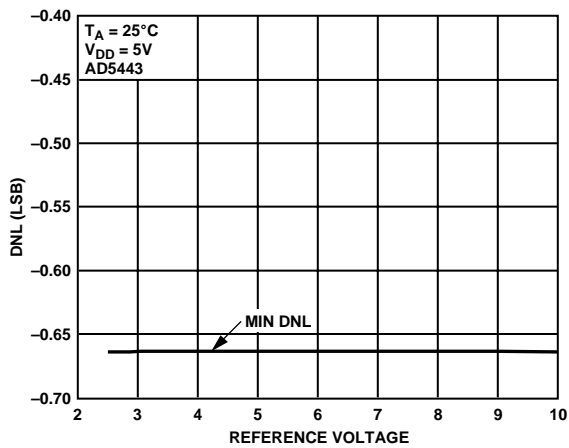


Figure 13. DNL vs. Reference Voltage

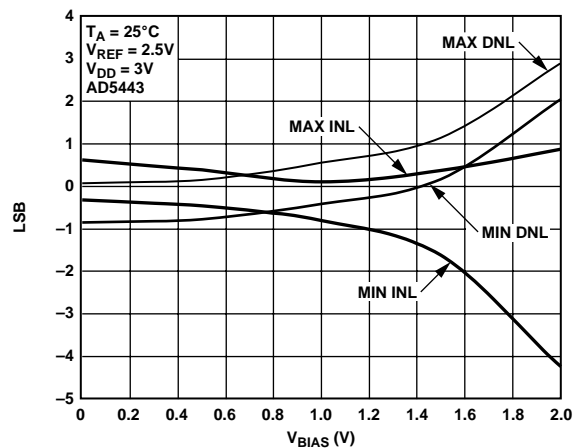


Figure 16. Linearity vs.  $V_{BIAS}$  Voltage Applied to  $I_{OUT2}$

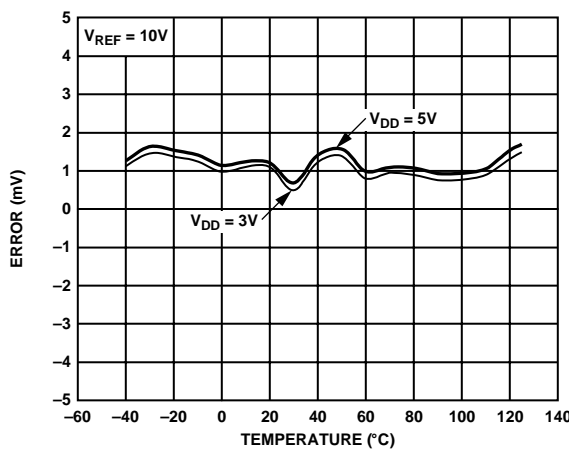


Figure 14. Gain Error vs. Temperature

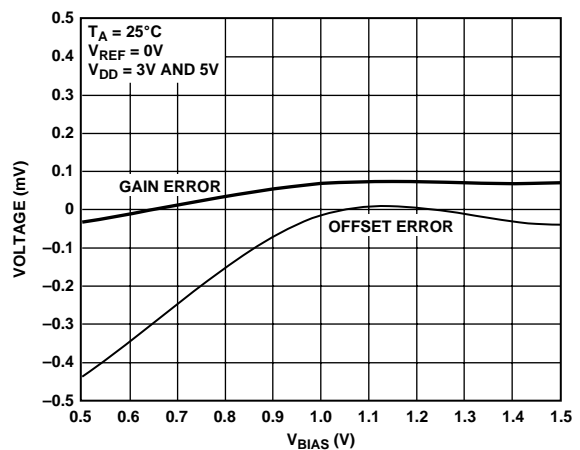


Figure 17. Gain and Offset Errors vs.  $V_{BIAS}$  Voltage Applied to  $I_{OUT2}$

# AD5426/AD5432/AD5443

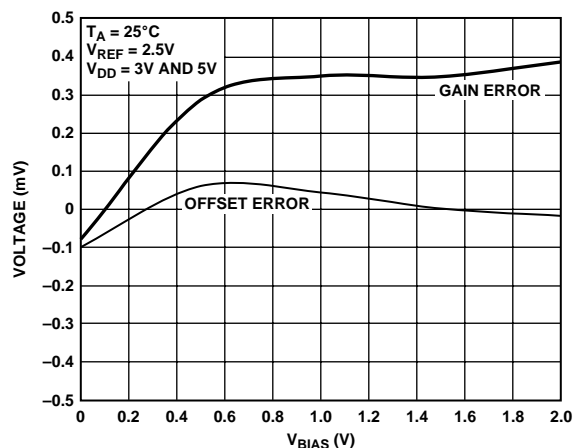


Figure 18. Gain and Offset Errors vs.  $V_{BIAS}$  Voltage Applied to  $I_{OUT2}$

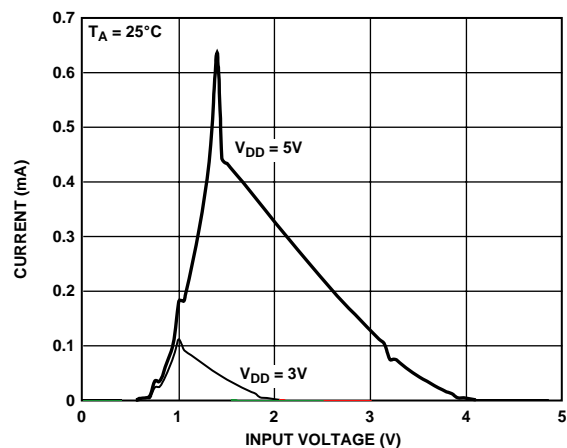


Figure 21. Supply Current vs. Logic Input Voltage,  $\overline{SYNC}$  (SCLK), DATA = 0

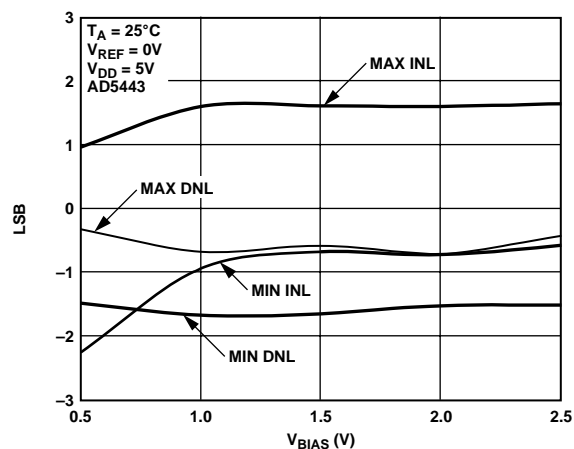


Figure 19. Linearity vs.  $V_{BIAS}$  Voltage Applied to  $I_{OUT2}$

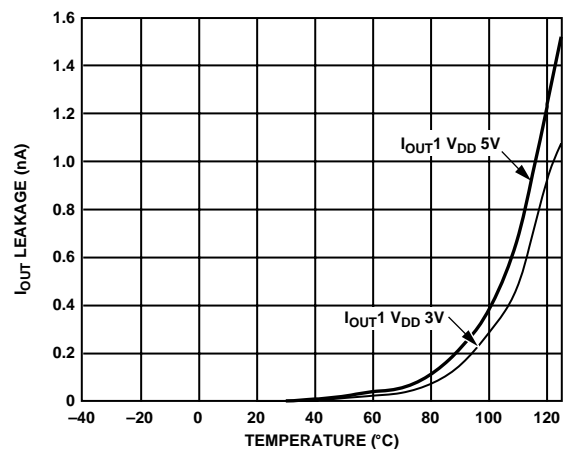


Figure 22.  $I_{OUT1}$  Leakage Current vs. Temperature

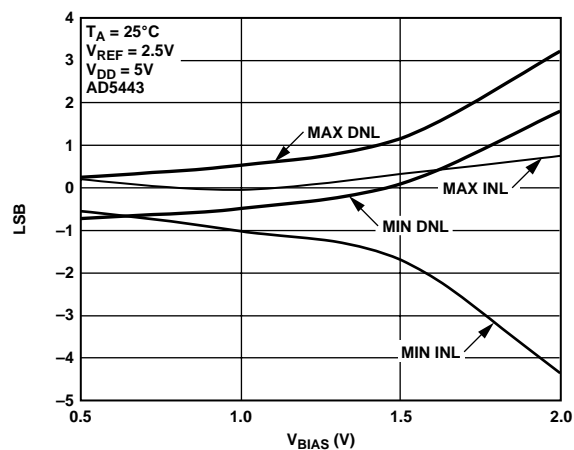


Figure 20. Linearity vs.  $V_{BIAS}$  Voltage Applied to  $I_{OUT2}$

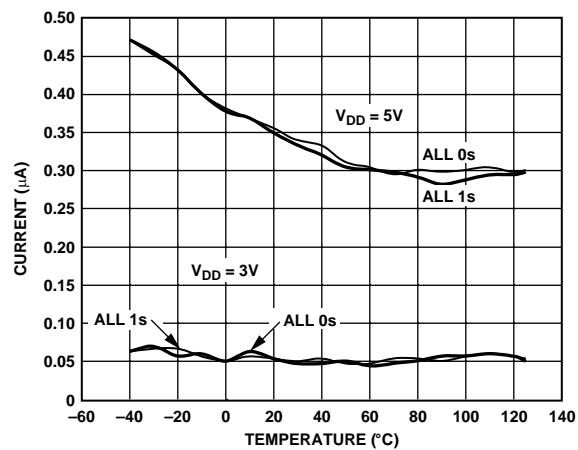


Figure 23. Supply Current vs. Temperature

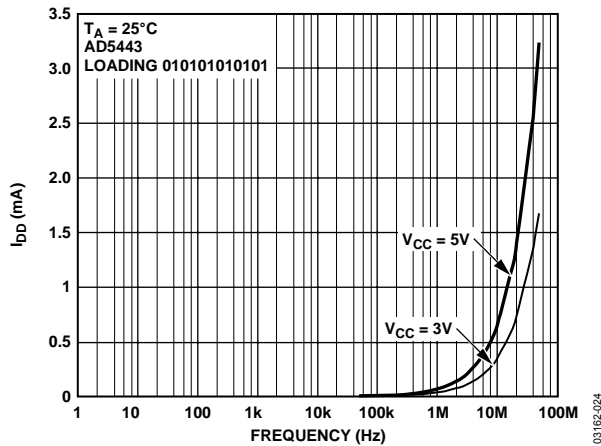


Figure 24. Supply Current vs. Update Rate

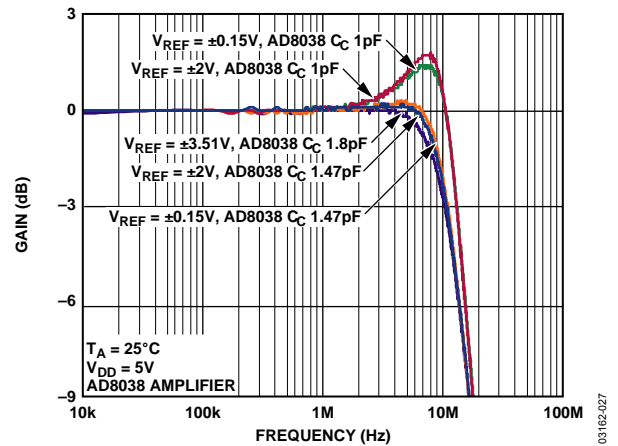


Figure 27. Reference Multiplying Bandwidth vs. Frequency and Compensation Capacitor

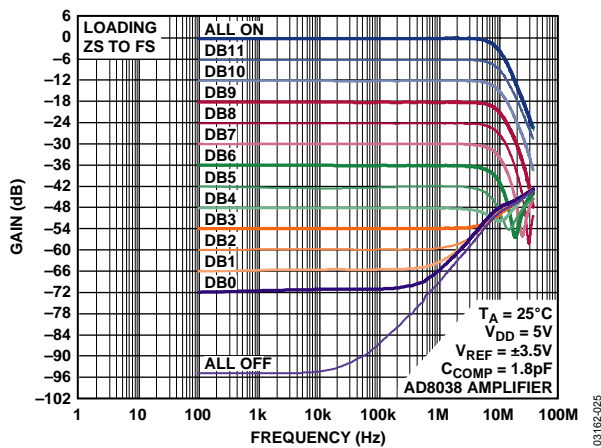


Figure 25. Reference Multiplying Bandwidth vs. Frequency and Code

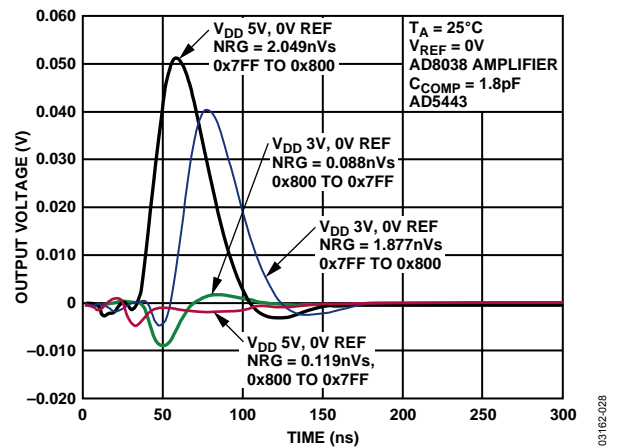


Figure 28. Midscale Transition  $V_{REF} = 0\text{ V}$

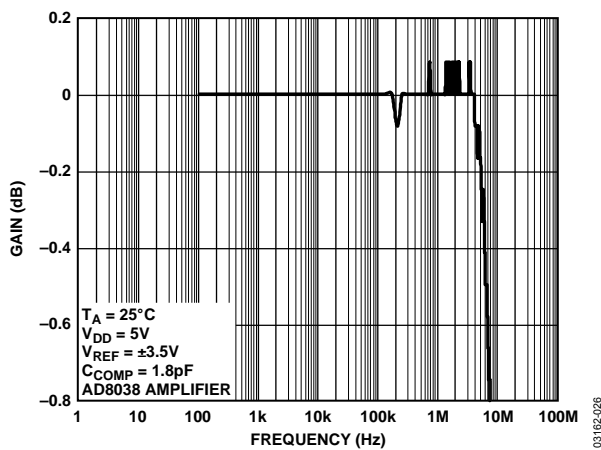


Figure 26. Reference Multiplying Bandwidth—All 1s Loaded

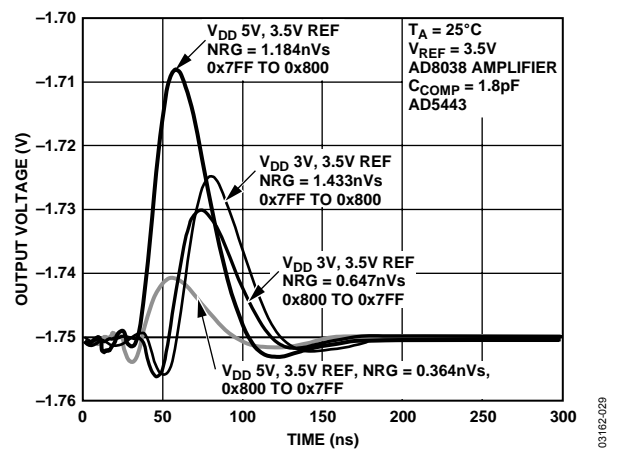


Figure 29. Midscale Transition  $V_{REF} = 3.5\text{ V}$

# AD5426/AD5432/AD5443

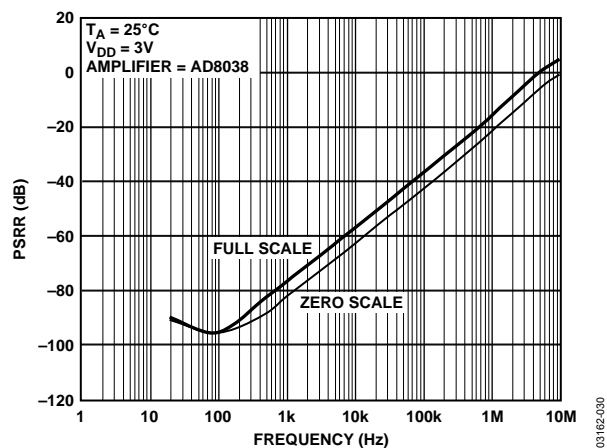


Figure 30. Power Supply Rejection vs. Frequency

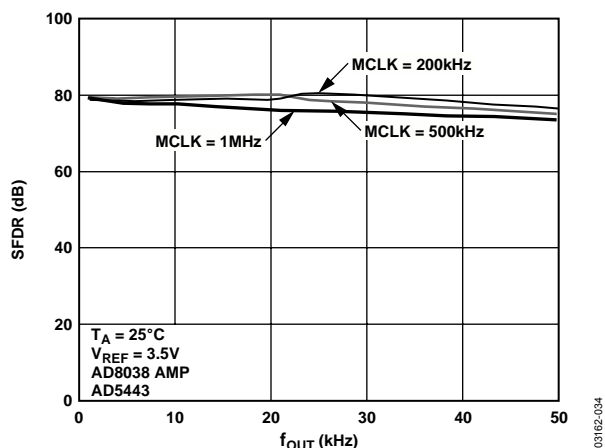


Figure 33. Wideband SFDR vs.  $f_{OUT}$  Frequency (AD5443)

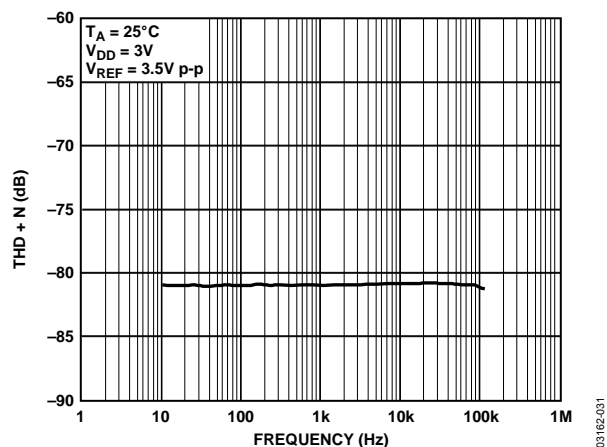


Figure 31. THD and Noise vs. Frequency

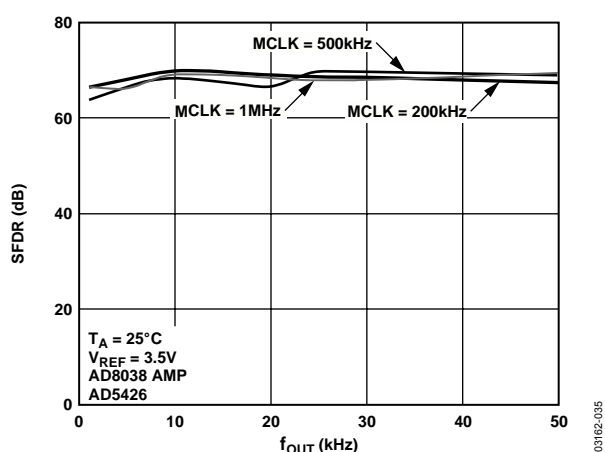


Figure 34. Wideband SFDR vs.  $f_{OUT}$  Frequency (AD5426)

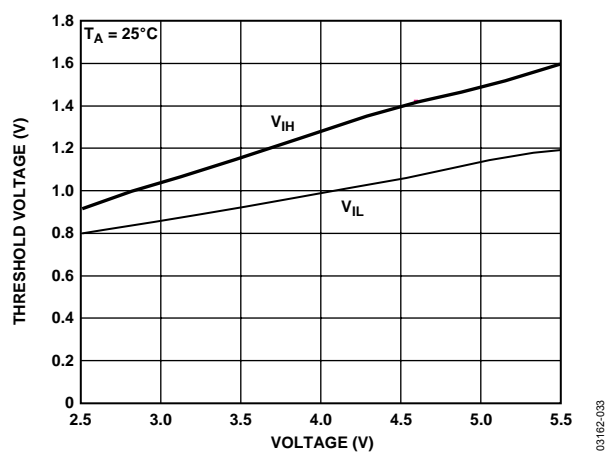


Figure 32. Threshold Voltages vs. Supply Voltage

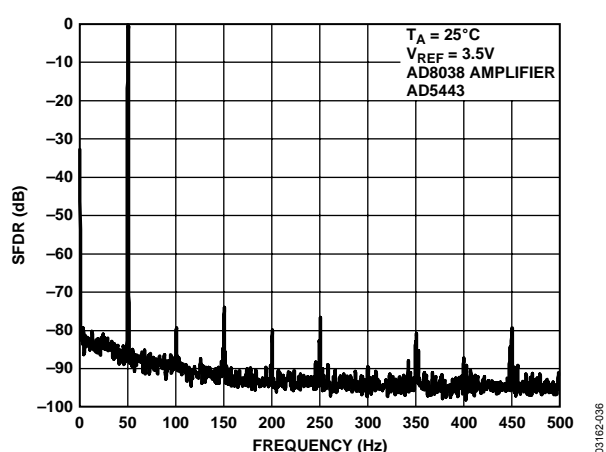


Figure 35. Wideband SFDR  $f_{OUT} = 50$  kHz, Update = 1 MHz

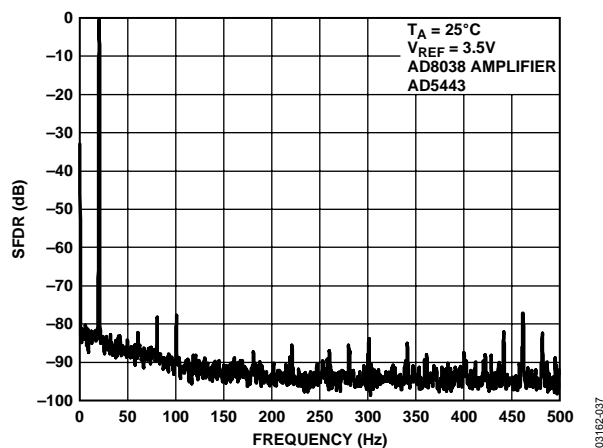


Figure 36. Wideband SFDR  $f_{OUT} = 20$  kHz, Update = 1 MHz

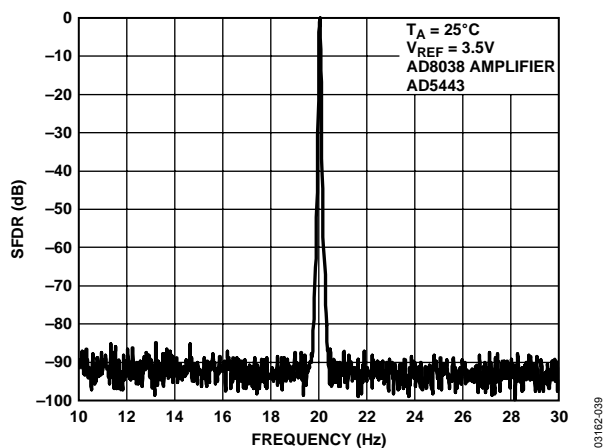


Figure 38. Narrowband ( $\pm 50\%$ ) SFDR  $f_{OUT} = 20$  kHz, Update = 1 MHz

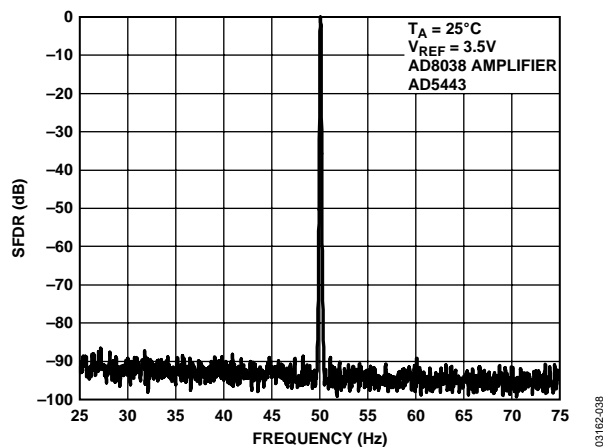


Figure 37. Narrowband ( $\pm 50\%$ ) SFDR  $f_{OUT} = 50$  kHz, Update = 1 MHz

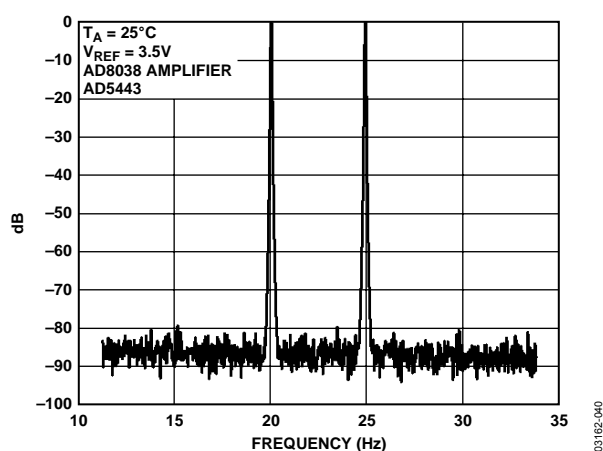


Figure 39. Narrowband ( $\pm 50\%$ ) IMD  $f_{OUT} = 20$  kHz, 25 kHz, Update = 1 MHz

## TERMINOLOGY

### Relative Accuracy

Relative accuracy or endpoint nonlinearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for 0 and full scale and is normally expressed in LSBs or as a percentage of full-scale reading.

### Differential Nonlinearity

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of  $-1$  LSB maximum over the operating temperature range ensures monotonicity.

### Gain Error

Gain error or full-scale error is a measure of the output error between an ideal DAC and the actual device output. For these DACs, ideal maximum output is  $V_{REF} - 1$  LSB. Gain error of the DACs is adjustable to 0 with external resistance.

### Output Leakage Current

Output leakage current is current that flows in the DAC ladder switches when these are turned off. For the  $I_{OUT1}$  terminal, it can be measured by loading all 0s to the DAC and measuring the  $I_{OUT1}$  current. Minimum current flows in the  $I_{OUT2}$  line when the DAC is loaded with all 1s.

### Output Capacitance

Capacitance from  $I_{OUT1}$  or  $I_{OUT2}$  to AGND.

### Output Current Settling Time

This is the amount of time it takes for the output to settle to a specified level for a full-scale input change. For these devices, it is specified with a  $100\ \Omega$  resistor to ground.

The settling time specification includes the digital delay from SYNC rising edge to the full-scale output charge.

### Digital-to-Analog Glitch Impulse

The amount of charge injected from the digital inputs to the analog output when the inputs change state. This is normally specified as the area of the glitch in either pA-s or nV-s depending upon whether the glitch is measured as a current or voltage signal.

### Digital Feedthrough

When the device is not selected, high frequency logic activity on the device digital inputs may be capacitively coupled to show up as noise on the  $I_{OUT}$  pins and subsequently into the following circuitry. This noise is digital feedthrough.

### Multiplying Feedthrough Error

This is the error due to capacitive feedthrough from the DAC reference input to the DAC  $I_{OUT1}$  terminal, when all 0s are loaded to the DAC.

### Total Harmonic Distortion (THD)

The DAC is driven by an ac reference. The ratio of the rms sum of the harmonics of the DAC output to the fundamental value is the THD. Usually only the lower order harmonics are included, such as second to fifth.

$$THD = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2}}{V_1}$$

### Digital Intermodulation Distortion

Second-order intermodulation distortion (IMD) measurements are the relative magnitude of the  $f_a$  and  $f_b$  tones generated digitally by the DAC and the second-order products at  $2f_a - f_b$  and  $2f_b - f_a$ .

### Spurious-Free Dynamic Range (SFDR)

SFDR is the usable dynamic range of a DAC before spurious noise interferes or distorts the fundamental signal. It is the measure of the difference in amplitude between the fundamental and the largest harmonically or nonharmonically related spur from dc to full Nyquist bandwidth (half the DAC sampling rate, or  $f_s/2$ ). Narrow band SFDR is a measure of SFDR over an arbitrary window size, in this case 50% of the fundamental. Digital SFDR is a measure of the usable dynamic range of the DAC when the signal is a digitally generated sine wave.

## THEORY OF OPERATION

The AD5426, AD5432, and AD5443 are 8-, 10-, and 12-bit current output DACs consisting of a standard inverting R-2R ladder configuration. A simplified diagram for the 8-bit AD5426 is shown in Figure 40. The matching feedback resistor,  $R_{FB}$ , has a value of  $R$ . The value of  $R$  is typically 10 k $\Omega$  (minimum 8 k $\Omega$  and maximum 12 k $\Omega$ ). If  $I_{OUT1}$  and  $I_{OUT2}$  are kept at the same potential, a constant current flows in each ladder leg, regardless of digital input code. Therefore, the input resistance presented at  $V_{REF}$  is always constant and nominally of value  $R$ . The DAC output ( $I_{OUT}$ ) is code-dependent, producing various resistances and capacitances. External amplifier choice should take into account the variation in impedance generated by the DAC on the amplifiers inverting input node.

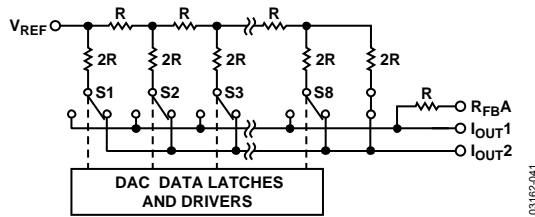


Figure 40. Simplified Ladder

Access is provided to the  $V_{REF}$ ,  $R_{FB}$ ,  $I_{OUT1}$ , and  $I_{OUT2}$  terminals of the DAC, making the device extremely versatile and allowing it to be configured in several different operating modes. For example, it can be configured to provide a unipolar output, 4-quadrant multiplication in bipolar or single-supply modes of operation. Note that a matching switch is used in series with the internal  $R_{FB}$  feedback resistor. If users attempt to measure  $R_{FB}$ , power must be applied to  $V_{DD}$  to achieve continuity.

### CIRCUIT OPERATION

#### Unipolar Mode

Using a single op amp, these devices can easily be configured to provide 2-quadrant multiplying operation or a unipolar output voltage swing, as shown in Figure 41.

When an output amplifier is connected in unipolar mode, the output voltage is given by

$$V_{OUT} = -V_{REF} \times \frac{D}{2^n}$$

where  $D$  is the fractional representation of the digital word loaded to the DAC, and  $n$  is the number of bits.

$$\begin{aligned} D &= 0 \text{ to } 255 \text{ (8-bit AD5426)} \\ &= 0 \text{ to } 1023 \text{ (10-bit AD5432)} \\ &= 0 \text{ to } 4095 \text{ (12-bit AD5443)} \end{aligned}$$

Note that the output voltage polarity is opposite to the  $V_{REF}$  polarity for dc reference voltages.

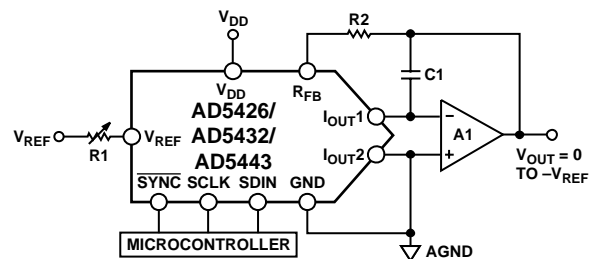
These DACs are designed to operate with either negative or positive reference voltages. The  $V_{DD}$  power pin is used by only the internal digital logic to drive the DAC switches' on and off states.

These DACs are also designed to accommodate ac reference input signals in the range of  $-10$  V to  $+10$  V.

With a fixed 10 V reference, the circuit shown in Figure 41 gives a unipolar 0 V to  $-10$  V output voltage swing. When  $V_{IN}$  is an ac signal, the circuit performs 2-quadrant multiplication. Table 5 shows the relationship between digital code and expected output voltage for unipolar operation (AD5426, 8-bit device).

Table 5. Unipolar Code Table

| Digital Input | Analog Output (V)                   |
|---------------|-------------------------------------|
| 1111 1111     | $-V_{REF}$ (255/256)                |
| 1000 0000     | $-V_{REF}$ (128/256) = $-V_{REF}/2$ |
| 0000 0001     | $-V_{REF}$ (1/256)                  |
| 0000 0000     | $-V_{REF}$ (0/256) = 0              |



#### NOTES

1. R1 AND R2 USED ONLY IF GAIN ADJUSTMENT IS REQUIRED.
2. C1 PHASE COMPENSATION (1pF TO 2pF) MAY BE REQUIRED IF A1 IS A HIGH SPEED AMPLIFIER.

Figure 41. Unipolar Operation

AD5426/AD5432/AD5443

Bipolar Operation

In some applications, it may be necessary to generate full 4-quadrant multiplying operation or a bipolar output swing. This can easily be accomplished by using another external amplifier and some external resistors, as shown in Figure 42. In this circuit, the second amplifier, A2, provides a gain of 2. Biasing the external amplifier with an offset from the reference voltage results in full 4-quadrant multiplying operation. The transfer function of this circuit shows that both negative and positive output voltages are created as the input data, D, which is incremented from code zero ( $V_{OUT} = -V_{REF}$ ) to midscale ( $V_{OUT} = 0\text{ V}$ ) to full scale ( $V_{OUT} = +V_{REF}$ ).

V\_OUT = (V\_REF \* D / (2^n - 1)) - V\_REF

where D is the fractional representation of the digital word loaded to the DAC and n is the resolution of the DAC.

- D= 0 to 255 (8-bit AD5426)
- = 0 to 1023 (10-bit AD5432)
- = 0 to 4095 (12-bit AD5443)

When V\_IN is an ac signal, the circuit performs 4-quadrant multiplication.

Table 6 shows the relationship between digital code and the expected output voltage for bipolar operation (AD5426, 8-bit device).

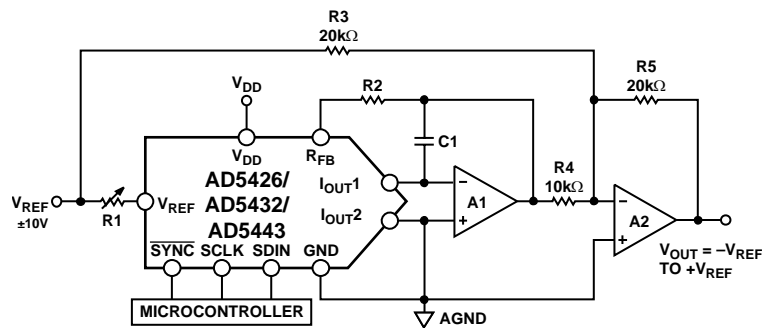
Table 6. Bipolar Code Table

| Digital Input | Analog Output (V)           |
|---------------|-----------------------------|
| 1111 1111     | +V <sub>REF</sub> (127/128) |
| 1000 0000     | 0                           |
| 0000 0001     | -V <sub>REF</sub> (127/128) |
| 0000 0000     | -V <sub>REF</sub> (128/128) |

Stability

In the I-to-V configuration, the I\_OUT of the DAC and the inverting node of the op amp must be connected as close as possible and proper PCB layout techniques must be employed. Since every code change corresponds to a step function, gain peaking may occur if the op amp has limited gain bandwidth product (GBP) and there is excessive parasitic capacitance at the inverting node. This parasitic capacitance introduces a pole into the open-loop response that can cause ringing or instability in closed-loop applications.

An optional compensation capacitor, C1, can be added in parallel with R\_FB for stability, as shown in Figure 41 and Figure 42. Too small a value of C1 can produce ringing at the output, while too large a value can adversely affect the settling time. C1 should be found empirically, but 1 pF to 2 pF is generally adequate for compensation.



- NOTES
- 1. R1 AND R2 ARE USED ONLY IF GAIN ADJUSTMENT IS REQUIRED. ADJUST R1 FOR  $V_{OUT} = 0\text{ V}$  WITH CODE 10000000 LOADED TO DAC.
  - 2. MATCHING AND TRACKING IS ESSENTIAL FOR RESISTOR PAIRS R3 AND R4.
  - 3. C1 PHASE COMPENSATION (1pF TO 2pF) MAY BE REQUIRED IF A1/A2 IS A HIGH SPEED AMPLIFIER.

03162-043

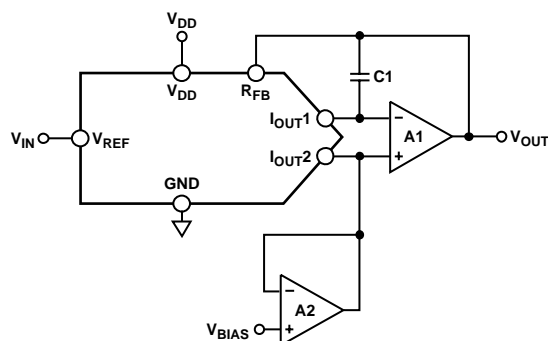
Figure 42. Bipolar Operation



## SINGLE-SUPPLY APPLICATIONS

### Current Mode Operation

These DACs are specified and tested to guarantee operation in single-supply applications. In the current mode circuit of Figure 43,  $I_{OUT2}$  and hence  $I_{OUT1}$  is biased positive by an amount applied to  $V_{BIAS}$ .



#### NOTES

1. ADDITIONAL PINS OMITTED FOR CLARITY.
2. C1 PHASE COMPENSATION (1pF TO 2pF) MAY BE REQUIRED IF A1 IS A HIGH SPEED AMPLIFIER.

03162-044

Figure 43. Single-Supply Current Mode Operation

In this configuration, the output voltage is given by

$$V_{OUT} = \left\{ D \times \left( R_{FB} / R_{DAC} \right) \times \left( V_{BIAS} - V_{IN} \right) \right\} + V_{BIAS}$$

As  $D$  varies from 0 to 255 (AD5426), 1023 (AD5432) or 4095 (AD5443), the output voltage varies from

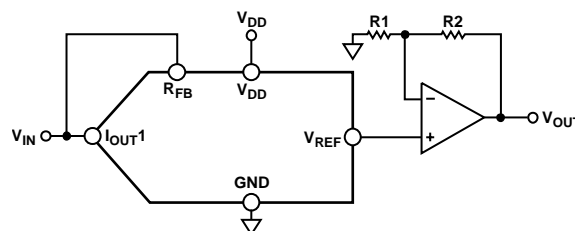
$$V_{OUT} = V_{BIAS} \text{ to } V_{OUT} = 2 V_{BIAS} - V_{IN}$$

$V_{BIAS}$  should be a low impedance source capable of sinking and sourcing all possible variations in current at the  $I_{OUT2}$  terminal without any problems.

It is important to note that  $V_{IN}$  is limited to low voltages because the switches in the DAC ladder no longer have the same source drain drive voltage. As a result, their on resistance differs, which degrades the linearity of the DAC. See Figure 15 to Figure 20.

### Voltage Switching Mode of Operation

Figure 44 shows these DACs operating in the voltage switching mode. The reference voltage,  $V_{IN}$ , is applied to the  $I_{OUT1}$  pin,  $I_{OUT2}$  is connected to AGND, and the output voltage is available at the  $V_{REF}$  terminal. In this configuration, a positive reference voltage results in a positive output voltage, making single-supply operation possible. The output from the DAC is voltage at a constant impedance (the DAC ladder resistance), thus an op amp is necessary to buffer the output voltage. The reference input no longer sees a constant input impedance, but one that varies with code. Therefore, the voltage input should be driven from a low impedance source.



#### NOTES

1. ADDITIONAL PINS OMITTED FOR CLARITY.
2. C1 PHASE COMPENSATION (1pF TO 2pF) MAY BE REQUIRED IF A1 IS A HIGH SPEED AMPLIFIER.

03162-045

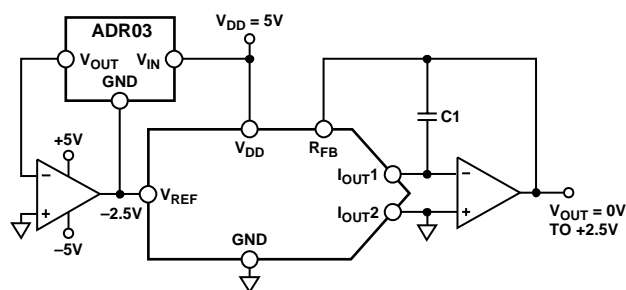
Figure 44. Single-Supply Voltage Switching Mode Operation

It is important to note that  $V_{IN}$  is limited to low voltages because the switches in the DAC ladder no longer have the same source drain drive voltage. As a result, their on resistance differs, which degrades the linearity of the DAC.

Also,  $V_{IN}$  must not go negative by more than 0.3 V or an internal diode turns on, exceeding the maximum ratings of the device. In this type of application, the full range of multiplying capability of the DAC is lost.

## POSITIVE OUTPUT VOLTAGE

Note that the output voltage polarity is opposite to the  $V_{REF}$  polarity for dc reference voltages. To achieve a positive voltage output, an applied negative reference to the input of the DAC is preferred over the output inversion through an inverting amplifier because of the resistor's tolerance errors. To generate a negative reference, the reference can be level shifted by an op amp such that the  $V_{OUT}$  and GND pins of the reference become the virtual ground and  $-2.5$  V, respectively, as shown in Figure 45.



#### NOTES

1. ADDITIONAL PINS OMITTED FOR CLARITY.
2. C1 PHASE COMPENSATION (1pF TO 2pF) MAY BE REQUIRED IF A1 IS A HIGH SPEED AMPLIFIER.

03162-046

Figure 45. Positive Voltage Output with Minimum of Components

## ADDING GAIN

In applications where the output voltage is required to be greater than  $V_{IN}$ , gain can be added with an additional external amplifier or it can be achieved in a single stage. It is important to consider the effect of temperature coefficients of the thin film resistors of the DAC. Simply placing a resistor in series with the  $R_{FB}$  resistor causes mismatches in the temperature coefficients, resulting in larger gain temperature coefficient errors. Instead,

the circuit shown in Figure 46 is a recommended method of increasing the gain of the circuit. R1, R2, and R3 should all have similar temperature coefficients, but they need not match the temperature coefficients of the DAC. This approach is recommended in circuits where gains of greater than 1 are required.

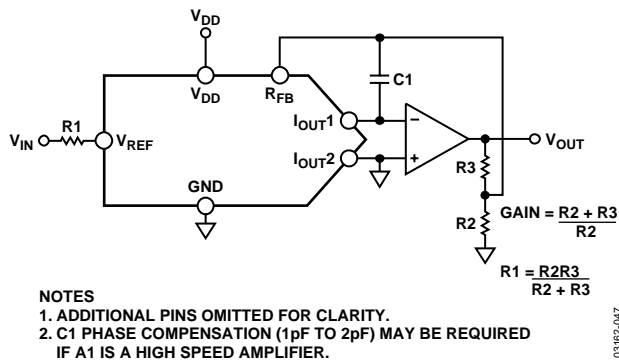


Figure 46. Increasing Gain of Current Output DAC

## DACS USED AS A DIVIDER OR PROGRAMMABLE GAIN ELEMENT

Current-steering DACs are very flexible and lend themselves to many different applications. If this type of DAC is connected as the feedback element of an op amp and R<sub>FB</sub> is used as the input resistor as shown in Figure 47, then the output voltage is inversely proportional to the digital input fraction, D.

For  $D = 1 - 2^{-n}$  the output voltage is

$$V_{OUT} = -V_{IN} / D = -V_{IN} / (1 - 2^{-n})$$

As D is reduced, the output voltage increases. For small values of D, it is important to ensure that the amplifier does not saturate and also that the required accuracy is met. For example, an 8-bit DAC driven with the binary code 0x10 (00010000), that is, 16 decimal, in the circuit of Figure 47 should cause the output voltage to be  $16 \times V_{IN}$ . However, if the DAC has a linearity specification of  $\pm 0.5$  LSB, then D can in fact have the weight anywhere in the range 15.5/256 to 16.5/256 so that the possible output voltage will be in the range  $15.5 V_{IN}$  to  $16.5 V_{IN}$ —an error of +3% even though the DAC itself has a maximum error of 0.2%.

DAC leakage current is also a potential error source in divider circuits. The leakage current must be counterbalanced by an opposite current supplied from the op amp through the DAC. Since only a fraction D of the current into the V<sub>REF</sub> terminal is routed to the I<sub>OUT1</sub> terminal, the output voltage has to change as follows:

$$\text{Output error voltage due to DAC leakage} = (\text{leakage} \times R) / D$$

where R is the DAC resistance at the V<sub>REF</sub> terminal. For a DAC leakage current of 10 nA, R = 10 kΩ, and a gain (that is, 1/D) of 16, the error voltage is 1.6 mV.

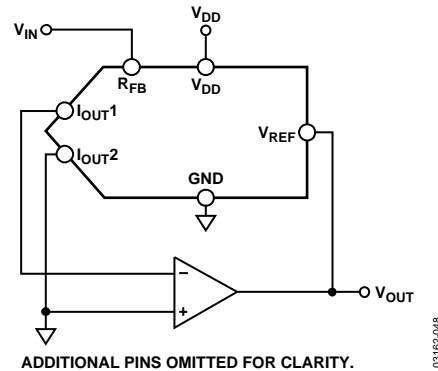


Figure 47. Current Steering DAC as a Divider or Programmable Gain Element

## REFERENCE SELECTION

When selecting a reference for use with the AD5426 series of current output DACs, pay attention to the references output voltage temperature coefficient specification. This parameter not only affects the full-scale error, but can also affect the linearity (INL and DNL) performance. The reference temperature coefficient should be consistent with the system accuracy specifications. For example, an 8-bit system required to hold its overall specification to within 1 LSB over the temperature range 0°C to 50°C dictates that the maximum system drift with temperature should be less than 78 ppm/°C. A 12-bit system with the same temperature range to overall specification within 2 LSBs requires a maximum drift of 10 ppm/°C. By choosing a precision reference with low output temperature coefficient this error source can be minimized. Table 7 suggests some references available from Analog Devices that are suitable for use with this range of current output DACs.

## AMPLIFIER SELECTION

The primary requirement for the current-steering mode is an amplifier with low input bias currents and low input offset voltage. The input offset voltage of an op amp is multiplied by the variable gain (due to the code-dependent output resistance of the DAC) of the circuit. A change in this noise gain between two adjacent digital fractions produces a step change in the output voltage due to the amplifier's input offset voltage. This output voltage change is superimposed on the desired change in output between the two codes and gives rise to a differential linearity error, which, if large enough, could cause the DAC to be nonmonotonic. In general, the input offset voltage should be a fraction ( $\sim < 1/4$ ) of an LSB to ensure monotonic behavior when stepping through codes.

The input bias current of an op amp also generates an offset at the voltage output as a result of the bias current flowing in the feedback resistor, R<sub>FB</sub>. Most op amps have input bias currents low enough to prevent any significant errors in 12-bit applications.

Common-mode rejection of the op amp is important in voltage switching circuits since it produces a code-dependent error at

the voltage output of the circuit. Most op amps have adequate common-mode rejection at a 8-, 10-, or 12-bit resolution.

Provided the DAC switches are driven from true wideband low impedance sources ( $V_{IN}$  and AGND), they settle quickly. Consequently, the slew rate and settling time of a voltage switching DAC circuit is determined largely by the output op amp. To obtain minimum settling time in this configuration, it is important to minimize capacitance at the  $V_{REF}$  of the DAC. This

is done by using low input capacitance buffer amplifiers and careful board design. Most single-supply circuits include ground as part of the analog signal range, which in turn requires an amplifier that can handle rail-to-rail signals. There is a large range of single-supply amplifiers available from Analog Devices.

**Table 7. Suitable ADI Precision References**

| Part No. | Output Voltage (V) | Initial Tolerance (%) | Temp Drift (ppm/°C) | $I_{SS}$ (mA) | Output Noise $\mu V$ p-p | Package       |
|----------|--------------------|-----------------------|---------------------|---------------|--------------------------|---------------|
| ADR01    | 10                 | 0.05                  | 3                   | 1             | 20                       | SOIC-8        |
| ADR01    | 10                 | 0.05                  | 9                   | 1             | 20                       | TSOT-23, SC70 |
| ADR02    | 5                  | 0.06                  | 3                   | 1             | 10                       | SOIC-8        |
| ADR02    | 5                  | 0.06                  | 9                   | 1             | 10                       | TSOT-23, SC70 |
| ADR03    | 2.5                | 0.10                  | 3                   | 1             | 6                        | SOIC-8        |
| ADR03    | 2.5                | 0.10                  | 9                   | 1             | 6                        | TSOT-23, SC70 |
| ADR06    | 3                  | 0.10                  | 3                   | 1             | 10                       | SOIC-8        |
| ADR06    | 3                  | 0.10                  | 9                   | 1             | 10                       | TSOT-23, SC70 |
| ADR431   | 2.5                | 0.04                  | 3                   | 0.8           | 3.5                      | SOIC-8        |
| ADR435   | 5                  | 0.04                  | 3                   | 0.8           | 8                        | SOIC-8        |
| ADR391   | 2.5                | 0.16                  | 9                   | 0.12          | 5                        | TSOT-23       |
| ADR395   | 5                  | 0.10                  | 9                   | 0.12          | 8                        | TSOT-23       |

**Table 8. Suitable ADI Precision Op Amps**

| Part No. | Supply Voltage (V)    | $V_{OS}$ (Max) ( $\mu V$ ) | $I_B$ (Max) (nA) | 0.1 Hz to 10 Hz Noise ( $\mu V$ p-p) | Supply Current ( $\mu A$ ) | Package      |
|----------|-----------------------|----------------------------|------------------|--------------------------------------|----------------------------|--------------|
| OP97     | $\pm 2$ to $\pm 20$   | 25                         | 0.1              | 0.5                                  | 600                        | SOIC-8       |
| OP1177   | $\pm 2.5$ to $\pm 15$ | 60                         | 2                | 0.4                                  | 500                        | MSOP, SOIC-8 |
| AD8551   | 2.7 to 5              | 5                          | 0.05             | 1                                    | 975                        | MSOP, SOIC-8 |
| AD8603   | 1.8 to 6              | 50                         | 0.001            | 2.3                                  | 50                         | TSOT         |
| AD8628   | 2.7 to 6              | 5                          | 0.1              | 0.5                                  | 850                        | TSOT, SOIC-8 |

**Table 9. Suitable ADI High Speed Op Amps**

| Part No. | Supply Voltage (V)    | BW @ $A_{CL}$ (MHz) | Slew Rate (V/ $\mu s$ ) | $V_{OS}$ (Max) ( $\mu V$ ) | $I_B$ (Max) (nA) | Package              |
|----------|-----------------------|---------------------|-------------------------|----------------------------|------------------|----------------------|
| AD8065   | 5 to 24               | 145                 | 180                     | 1,500                      | 6,000            | SOIC-8, SOT-23, MSOP |
| AD8021   | $\pm 2.5$ to $\pm 12$ | 490                 | 100                     | 1,000                      | 10,500           | SOIC-8, MSOP         |
| AD8038   | 3 to 12               | 350                 | 425                     | 3,000                      | 750              | SOIC-8, SC70-5       |
| AD9631   | $\pm 2$ to $\pm 6$    | 320                 | 1,300                   | 10,000                     | 7,000            | SOIC-8               |

## SERIAL INTERFACE

The AD5426/AD5432/AD5443 have an easy to use 3-wire interface that is compatible with SPI/QSPI/MICROWIRE and DSP interface standards. Data is written to the device in 16 bit words. This 16-bit word consists of 4 control bits and either 8-, 10-, or 12-data bits as shown in Figure 48, Figure 49, and Figure 50. The AD5443 uses all 12 bits of DAC data. The AD5432 uses 10 bits and ignores the 2 LSBs, while the AD5426 uses 8 bits and ignores the last 4 bits.

### Low Power Serial Interface

To minimize the power consumption of the device, the interface powers up fully only when the device is being written to, i.e., on the falling edge of  $\overline{\text{SYNC}}$ . The SCLK and DIN input buffers are powered down on the rising edge of  $\overline{\text{SYNC}}$ .

### DAC Control Bits C3 to C0

Control Bits C3 to C0 allow control of various functions of the DAC, as seen in Table 10. Default settings of the DAC on power-on are as follows: Data is clocked into the shift register on falling clock edges and daisy-chain mode is enabled. Device powers on with zero-scale load to the DAC register and I<sub>OUT</sub> lines.

The DAC control bits allow the user to adjust certain features on power-on, for example, daisy-chaining may be disabled if not in use, active clock edge may be changed to rising edge, and DAC output may be cleared to either zero scale or midscale. The user may also initiate a readback of the DAC register contents for verification purposes.

**Table 10. DAC Control Bits**

| C3 | C2 | C1 | C0 | Function Implemented                        |
|----|----|----|----|---|
| 0  | 0  | 0  | 0  | No operation (power-on default)             |
| 0  | 0  | 0  | 1  | Load and update                             |
| 0  | 0  | 1  | 0  | Initiate readback                           |
| 0  | 0  | 1  | 1  | Reserved                                    |
| 0  | 1  | 0  | 0  | Reserved                                    |
| 0  | 1  | 0  | 1  | Reserved                                    |
| 0  | 1  | 1  | 0  | Reserved                                    |
| 0  | 1  | 1  | 1  | Reserved                                    |
| 1  | 0  | 0  | 0  | Reserved                                    |
| 1  | 0  | 0  | 1  | Daisy-chain disable                         |
| 1  | 0  | 1  | 0  | Clock data to shift register on rising edge |
| 1  | 0  | 1  | 1  | Clear DAC output to zero scale              |
| 1  | 1  | 0  | 0  | Clear DAC output to midscale                |
| 1  | 1  | 0  | 1  | Reserved                                    |
| 1  | 1  | 1  | 0  | Reserved                                    |
| 1  | 1  | 1  | 1  | Reserved                                    |

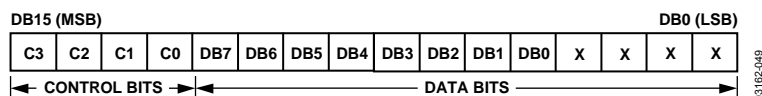


Figure 48. AD5426 8-Bit Input Shift Register Contents

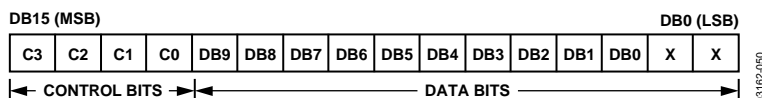


Figure 49. AD5432 10-Bit Input Shift Register Contents

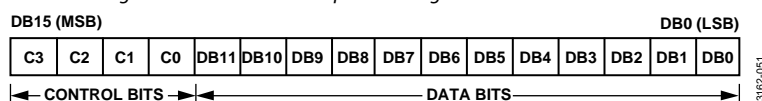


Figure 50. AD5443 12-Bit Input Shift Register Contents

### SYNC Function

$\overline{\text{SYNC}}$  is an edge-triggered input that acts as a frame synchronization signal and chip enable. Data can be transferred into the device only while  $\overline{\text{SYNC}}$  is low. To start the serial data transfer,  $\overline{\text{SYNC}}$  should be taken low observing the minimum  $\overline{\text{SYNC}}$  falling to SCLK falling edge setup time,  $t_4$ .

### Daisy-Chain Mode

Daisy-chain is the default power-on mode. To disable the daisy chain function, write 1001 to the control word. In daisy-chain mode, the internal gating on SCLK is disabled. The SCLK is continuously applied to the input shift register when  $\overline{\text{SYNC}}$  is low. If more than 16 clock pulses are applied, the data ripples out of the shift register and appears on the SDO line. This data is clocked out on the rising edge of SCLK (this is the default, use the control word to change the active edge) and is valid for the next device on the falling edge (default). By connecting this line to the D<sub>IN</sub> input on the next device in the chain, a multidevice interface is constructed. Sixteen clock pulses are required for each device in the system. Therefore, the total number of clock cycles must equal 16 N where N is the total number of devices in the chain. See the timing diagram in Figure 4.

When the serial transfer to all devices is complete,  $\overline{\text{SYNC}}$  should be taken high. This prevents any further data being clocked into the input shift register. A burst clock containing the exact number of clock cycles may be used and  $\overline{\text{SYNC}}$  taken high some time later. After the rising edge of  $\overline{\text{SYNC}}$ , data is automatically transferred from each device's input shift register to the addressed DAC.

When control bits = 0000, the device is in no operation mode. This may be useful in daisy-chain applications where the user does not want to change the settings of a particular DAC in the chain. Simply write 0000 to the control bits for that DAC and the following data bits will be ignored.

## Standalone Mode

After power-on, write 1001 to the control word to disable daisy-chain mode. The first falling edge of  $\overline{\text{SYNC}}$  resets a counter that counts the number of serial clocks, ensuring the correct number of bits are shifted in and out of the serial shift registers. A rising edge on  $\overline{\text{SYNC}}$  during a write causes the write cycle to be aborted.

After the falling edge of the 16th SCLK pulse, data is automatically transferred from the input shift register to the DAC. For another serial transfer to take place, the counter must be reset by the falling edge of  $\overline{\text{SYNC}}$ .

## MICROPROCESSOR INTERFACE

Microprocessor interfacing to this family of DACs is via a serial bus that uses standard protocol compatible with microcontrollers and DSP processors. The communications channel is a 3-wire interface consisting of a clock signal, a data signal, and a synchronization signal. The devices require a 16-bit word with a data valid default on the falling edge of SCLK, but this is changeable via the control bits in the data-word.

### ADSP-21xx to AD5426/AD5432/AD5443 Interface

The ADSP-21xx family of DSPs are easily interfaced to this family of DACs without extra glue logic. Figure 51 shows an example of an SPI interface between the DAC and the ADSP-2191M. SCK of the DSP drives the serial data line, DIN.  $\overline{\text{SYNC}}$  is driven from one of the port lines, in this case  $\text{SPiXSEL}$ .

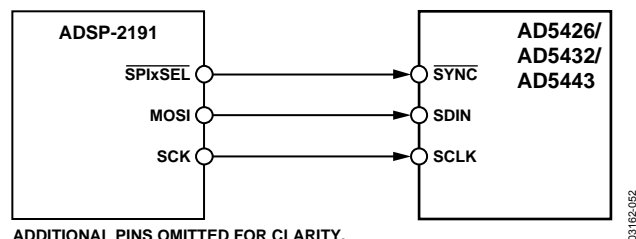


Figure 51. ADSP-2191 SPI-to-AD5426/AD5432/AD5443 Interface

A serial interface between the DAC and DSP channel synchronous serial port (SPORT) is shown in Figure 52. In this interface example, SPORT0 is used to transfer data to the DAC shift register. Transmission is initiated by writing a word to the Tx register after the SPORT has been enabled. In a write sequence, data is clocked out on each rising edge of the DSP's serial clock and clocked into the DAC input shift register on the falling edge of its SCLK. The update of the DAC output takes place on the rising edge of the  $\overline{\text{SYNC}}$  signal.

Communication between two devices at a given clock speed is possible when the following specifications are compatible: frame sync delay and frame sync setup and hold, data delay and data setup and hold, and SCLK width. The DAC interface expects a  $t_4$  ( $\overline{\text{SYNC}}$  falling edge to SCLK falling edge setup time) of 13 ns minimum. Consult the ADSP-21xx user manual for information on clock and frame sync frequencies for the SPORT register. Table 11 shows the SPORT control register.

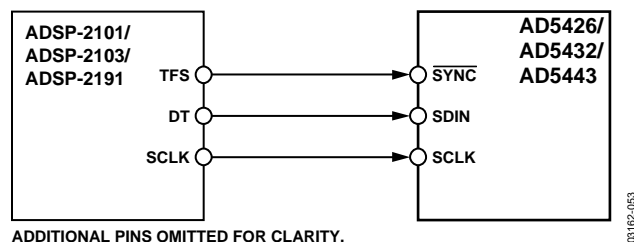


Figure 52. ADSP-2101/ADSP-2103/ADSP-2191 SPORT to AD5426/AD5432/AD5443 Interface

Table 11. SPORT Control Register Setup

| Name   | Setting | Description             |
|--------|---------|-------------------------|
| TFSW   | 1       | Alternate framing       |
| INVTFS | 1       | Active low frame signal |
| DTYPE  | 00      | Right-justify data      |
| ISCLK  | 1       | Internal serial clock   |
| TFSR   | 1       | Frame every word        |
| ITFS   | 1       | Internal framing signal |
| SLEN   | 1111    | 16-bit data-word        |

### ADSP-BF5xx to AD5426/AD5432/AD5443 Interface

The ADSP-BF5xx family of processors has an SPI-compatible port that enables the processor to communicate with SPI-compatible devices. A serial interface between the ADSP-BF5xx and the AD526/AD5432/AD5443 DAC is shown in Figure 53. In this configuration, data is transferred through the master output/slave input (MOSI) pin.  $\overline{\text{SYNC}}$  is driven by the SPI chip select pin, which is a reconfigured programmable flag pin.

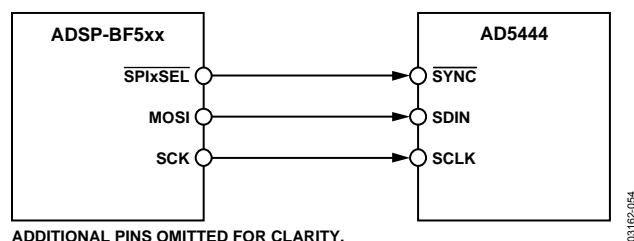


Figure 53. ADSP-BF5xx-to-AD5426/AD5432/AD5443 Interface

The ADSP-BF5xx processor incorporates the SPORT. A serial interface between the DAC and the DSP SPORT is shown in Figure 54. When the SPORT is enabled, initiate transmission by writing a word to the Tx register. The data is clocked out on each rising edge of the DSP's serial clock and clocked into the DAC's input shift register on the falling edge of its SCLK. The DAC output is updated by using the transmit frame synchronization (TFS) line to provide a  $\overline{\text{SYNC}}$  signal.

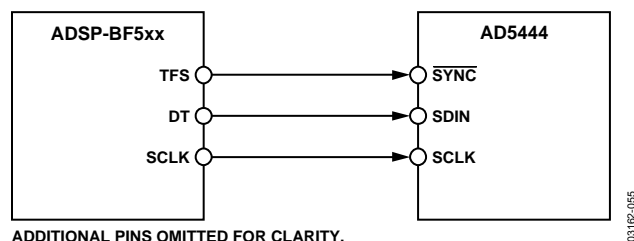


Figure 54. ADSP-BF5xx-to-AD5426/AD5432/AD5443 Interface



# AD5426/AD5432/AD5443

## 80C51/80L51 to AD5426/AD5432/AD5443 Interface

A serial interface between the DAC and the 8051 is shown in Figure 55. TxD of the 8051 drives SCLK of the DAC serial interface, while RxD drives the serial data line, DIN. P3.3 is a bit-programmable pin on the serial port and is used to drive SYNC. When data is to be transmitted to the switch, P3.3 is taken low. The 80C51/80L51 transmits data only in 8-bit bytes; thus, only eight falling clock edges occur in the transmit cycle. To load data correctly to the DAC, P3.3 is left low after the first eight bits are transmitted, and a second write cycle is initiated to transmit the second byte of data. Data on RxD is clocked out of the microcontroller on the rising edge of TxD and is valid on the falling edge. As a result, no glue logic is required between the DAC and microcontroller interface. P3.3 is taken high following the completion of this cycle. The 8051 provides the LSB of its SBUF register as the first bit in the data stream. The DAC input register requires its data with the MSB as the first bit received. The transmit routine should take this into account.

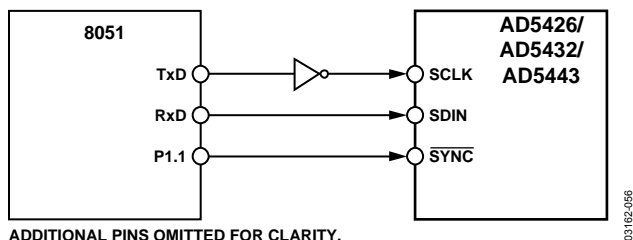


Figure 55. 80C51/80L51-to-AD5426/AD5432/AD5443 Interface

## MC68HC11 Interface to AD5426/AD5432/AD5443 Interface

Figure 56 shows an example of a serial interface between the DAC and the MC68HC11 microcontroller. The SPI on the MC68HC11 is configured for master mode (MSTR) = 1, clock polarity bit (CPOL) = 0, and the clock phase bit (CPHA) = 1. The SPI is configured by writing to the SPI control register (SPCR)—see the 68HC11 user manual. SCK of the 68HC11 drives the SCLK of the DAC interface, the MOSI output drives the serial data line (DIN) of the AD5426/AD5432/AD5443. The SYNC signal is derived from a port line (PC7). When data is being transmitted to the DAC, the SYNC line is taken low (PC7). Data appearing on the MOSI output is valid on the falling edge of SCK. Serial data from the 68HC11 is transmitted in 8-bit bytes with only eight falling clock edges occurring in the transmit cycle. Data is transmitted MSB first. To load data to the DAC, PC7 is left low after the first eight bits are transferred and a second serial write operation is performed to the DAC. PC7 is taken high at the end of this procedure.

If the user wants to verify the data previously written to the input shift register, the SDO line can be connected to MISO of the MC68HC11, and with SYNC low, the shift register would clock data out on the rising edges of SCLK.

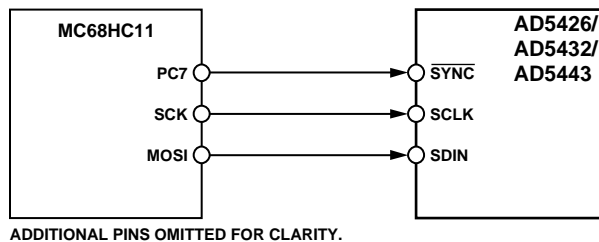


Figure 56. 68HC11/68L11-to-AD5426/AD5432/AD5443 Interface

## MICROWIRE to AD5426/AD5432/AD5443 Interface

Figure 57 shows an interface between the DAC and any MICROWIRE-compatible device. Serial data is shifted out on the falling edge of the serial clock, SK, and is clocked into the DAC input shift register on the rising edge of SK, which corresponds to the falling edge of the DACs SCLK.

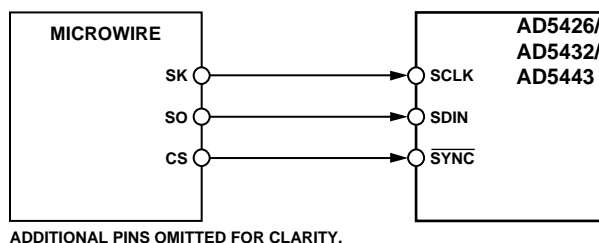


Figure 57. MICROWIRE-to-AD5426/AD5432/AD5443 Interface

## PIC16C6x/7x to AD5426/AD5432/AD5443

The PIC16C6x/7x synchronous serial port (SSP) is configured as an SPI master with the clock polarity bit (CKP) = 0. This is done by writing to the synchronous serial port control register (SSPCON). See the PIC16/17 Microcontroller User Manual. In this example, I/O port RA1 is being used to provide a SYNC signal and to enable the serial port of the DAC. This microcontroller transfers only eight bits of data during each serial transfer operation; therefore, two consecutive write operations are required. Figure 58 shows the connection diagram.

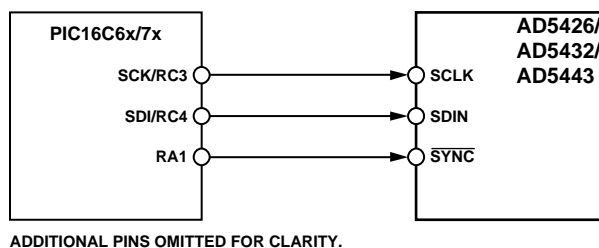


Figure 58. PIC16C6x/7x-to-AD5426/AD5432/AD5443 Interface

## PCB LAYOUT AND POWER SUPPLY DECOUPLING

In any circuit where accuracy is important, careful consideration of the power supply and ground return layout helps to ensure the rated performance. The printed circuit board on which the AD5426/AD5432/AD5443 is mounted should be designed so that the analog and digital sections are separated and confined to certain areas of the board. If the DAC is in a system where multiple devices require an AGND-to-DGND connection, the connection should be made at one point only. The star ground point should be established as close to the device as possible.

The DAC should have ample supply bypassing of 10  $\mu\text{F}$  in parallel with 0.1  $\mu\text{F}$  on the supply located as close to the package as possible, ideally right up against the device. The 0.1  $\mu\text{F}$  capacitor should have low effective series resistance (ESR) and effective series inductance (ESI), like the common ceramic types that provide a low impedance path to ground at high frequencies to handle transient currents due to internal logic switching. Low ESR, 1  $\mu\text{F}$  to 10  $\mu\text{F}$  tantalum or electrolytic capacitors should also be applied at the supplies to minimize transient disturbance and filter out low frequency ripple.

Fast switching signals such as clocks should be shielded with digital ground to avoid radiating noise to other parts of the board and should never be run near the reference inputs.

Avoid crossover of digital and analog signals. Traces on opposite sides of the board should run at right angles to each other. This reduces the effects of feedthrough through the board. A microstrip technique is by far the best, but not always possible with a double-sided board. In this technique, the component side of the board is dedicated to ground plane while signal traces are placed on the solder side.

It is good practice to employ compact, minimum lead length PCB layout design. Leads to the input should be as short as possible to minimize IR drops and stray inductance.

The PCB metal traces between  $V_{\text{REF}}$  and  $R_{\text{FB}}$  should also be matched to minimize gain error. To maximize on high frequency performance, the I-to-V amplifier should be located as close to the device as possible.

### EVALUATION BOARD FOR THE AD5426/AD5432/AD5443 SERIES OF DACS

The evaluation board consists of a 12-bit AD5443 and a current-to-voltage amplifier, the AD8065. Included on the evaluation board is a 10 V reference, the ADR01. An external reference may also be applied via an SMB input.

The evaluation kit consists of a CD-ROM with self-installing PC software to control the DAC. The software simply allows the user to write a code to the device.

### OPERATING THE EVALUATION BOARD

#### Power Supplies

The board requires  $\pm 12\text{ V}$  and  $+5\text{ V}$  supplies. The  $+12\text{ V } V_{\text{DD}}$  and  $V_{\text{SS}}$  are used to power the output amplifier, while the  $+5\text{ V}$  is used to power the DAC ( $V_{\text{DD1}}$ ) and transceivers ( $V_{\text{CC}}$ ).

Both supplies are decoupled to their respective ground plane with 10  $\mu\text{F}$  tantalum and 0.1  $\mu\text{F}$  ceramic capacitors. Link1 (LK1) is provided to allow selection between the on-board reference (ADR01) or an external reference applied through J2. For the AD5426/AD5432/AD5443 use Link2 in the SDO position.

# AD5426/AD5432/AD5443

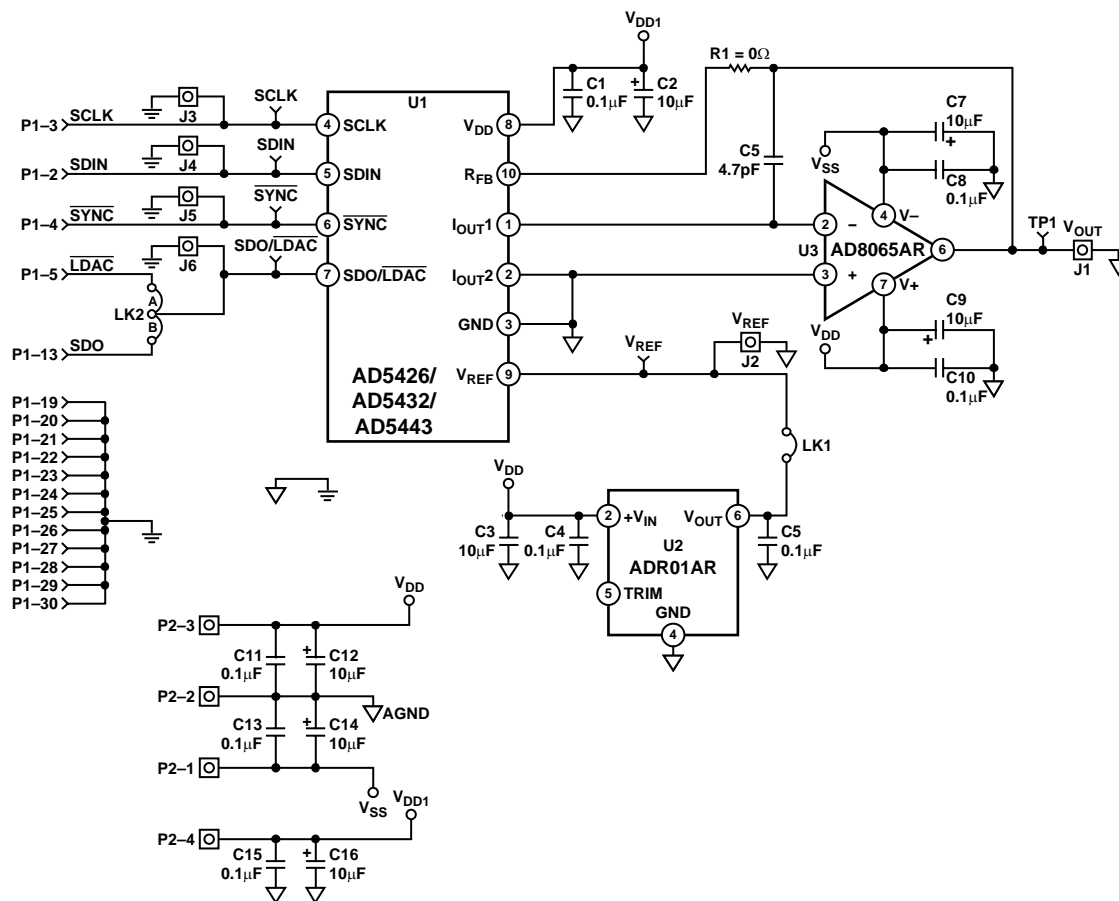


Figure 59. Schematic of AD5426/AD5432/AD5443 Evaluation Board

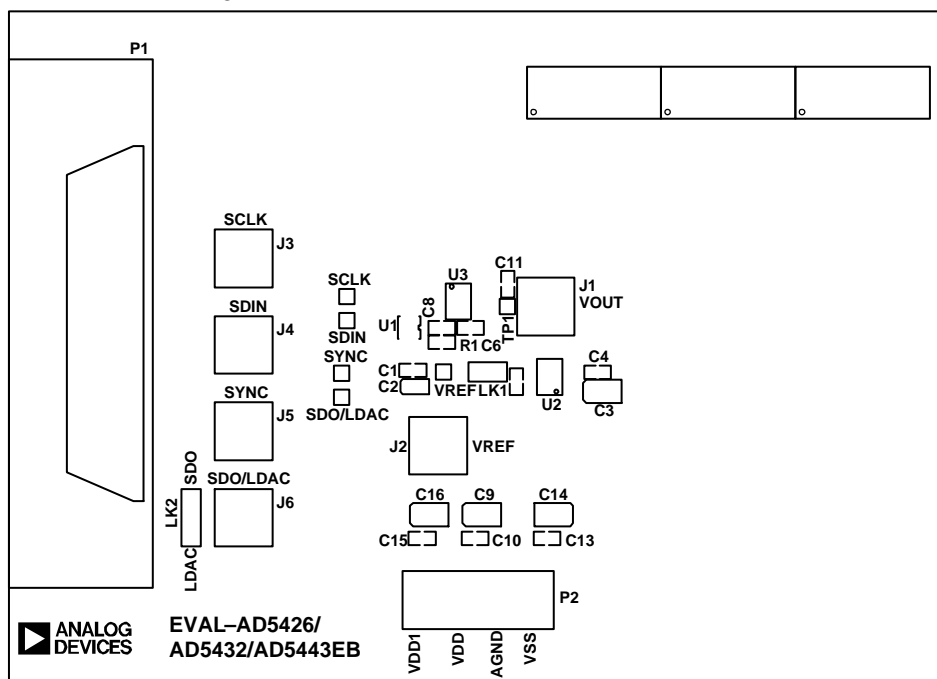
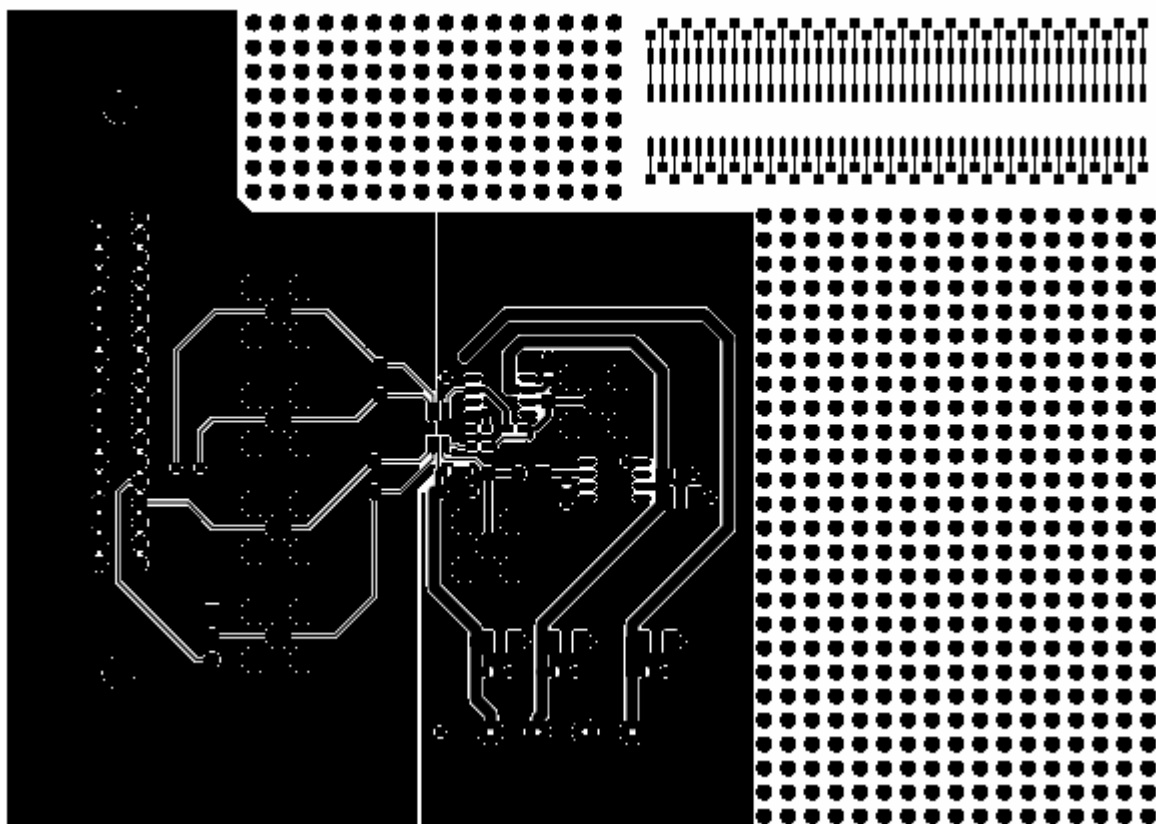


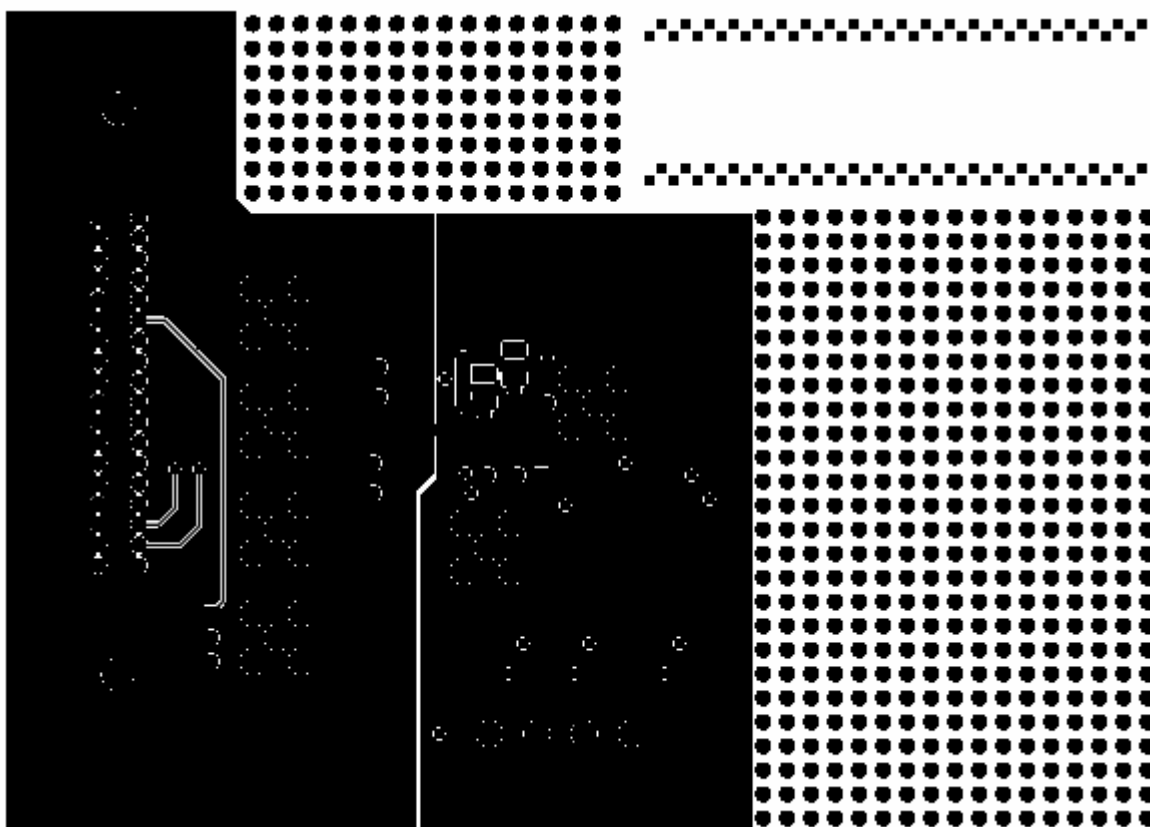
Figure 60. Silkscreen—Component Side View (Top Layer)





03161-047

*Figure 61. Component Side Artwork*



03161-049

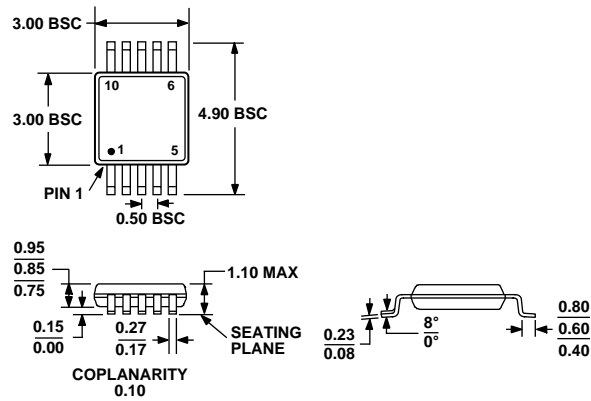
Figure 62. Solder Side Artwork

## OVERVIEW OF AD54xx AND AD55xx DEVICES

Table 12.

| Part No. | Resolution | No. DACs | INL (LSB)  | Interface | Package      | Features                                     |
|----------|------------|----------|------------|-----------|--------------|--|
| AD5424   | 8          | 1        | $\pm 0.25$ | Parallel  | RU-16, CP-20 | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5426   | 8          | 1        | $\pm 0.25$ | Serial    | RM-10        | 10 MHz BW, 50 MHz serial                     |
| AD5428   | 8          | 2        | $\pm 0.25$ | Parallel  | RU-20        | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5429   | 8          | 2        | $\pm 0.25$ | Serial    | RU-10        | 10 MHz BW, 50 MHz serial                     |
| AD5450   | 8          | 1        | $\pm 0.25$ | Serial    | RJ-8         | 10 MHz BW, 50 MHz serial                     |
| AD5432   | 10         | 1        | $\pm 0.5$  | Serial    | RM-10        | 10 MHz BW, 50 MHz serial                     |
| AD5433   | 10         | 1        | $\pm 0.5$  | Parallel  | RU-20, CP-20 | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5439   | 10         | 2        | $\pm 0.5$  | Serial    | RU-16        | 10 MHz BW, 50 MHz serial                     |
| AD5440   | 10         | 2        | $\pm 0.5$  | Parallel  | RU-24        | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5451   | 10         | 1        | $\pm 0.25$ | Serial    | RJ-8         | 10 MHz BW, 50 MHz serial                     |
| AD5443   | 12         | 1        | $\pm 1$    | Serial    | RM-10        | 10 MHz BW, 50 MHz serial                     |
| AD5444   | 12         | 1        | $\pm 0.5$  | Serial    | RM-8         | 50 MHz serial interface                      |
| AD5415   | 12         | 2        | $\pm 1$    | Serial    | RU-24        | 10 MHz BW, 50 MHz serial                     |
| AD5405   | 12         | 2        | $\pm 1$    | Parallel  | CP-40        | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5445   | 12         | 2        | $\pm 1$    | Parallel  | RU-20, CP-20 | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5447   | 12         | 2        | $\pm 1$    | Parallel  | RU-24        | 10 MHz BW, 17 ns $\overline{CS}$ pulse width |
| AD5449   | 12         | 2        | $\pm 1$    | Serial    | RU-16        | 10 MHz BW, 50 MHz serial                     |
| AD5452   | 12         | 1        | $\pm 0.5$  | Serial    | RJ-8, RM-8   | 10 MHz BW, 50 MHz serial                     |
| AD5446   | 14         | 1        | $\pm 1$    | Serial    | RM-8         | 10 MHz BW, 50 MHz serial                     |
| AD5453   | 14         | 1        | $\pm 2$    | Serial    | UJ-8, RM-8   | 10 MHz BW, 50 MHz serial                     |
| AD5553   | 14         | 1        | $\pm 1$    | Serial    | RM-8         | 4 MHz BW, 50 MHz serial clock                |
| AD5556   | 14         | 1        | $\pm 1$    | Parallel  | RU-28        | 4 MHz BW, 20 ns $\overline{WR}$ pulse width  |
| AD5555   | 14         | 2        | $\pm 1$    | Serial    | RM-8         | 4 MHz BW, 50 MHz serial clock                |
| AD5557   | 14         | 2        | $\pm 1$    | Parallel  | RU-38        | 4 MHz BW, 20 ns $\overline{WR}$ pulse width  |
| AD5543   | 16         | 1        | $\pm 2$    | Serial    | RM-8         | 4 MHz BW, 50 MHz serial clock                |
| AD5546   | 16         | 1        | $\pm 2$    | Parallel  | RU-28        | 4 MHz BW, 20 ns $\overline{WR}$ pulse width  |
| AD5545   | 16         | 2        | $\pm 2$    | Serial    | RU-16        | 4 MHz BW, 50 MHz serial clock                |
| AD5547   | 16         | 2        | $\pm 2$    | Parallel  | RU-38        | 4 MHz BW, 20 ns $\overline{WR}$ pulse width  |

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-187BA

Figure 63. 10-Lead Mini Small Outline Package [MSOP]  
(RM-10)

Dimensions shown in millimeters

## ORDERING GUIDE

| Model                         | Resolution (Bit) | INL (LSB) | Temperature Range | Package Description | Branding | Package Option |
|-------------------------------|------------------|-----------|-------------------|---------------------|----------|----------------|
| AD5426YRM                     | 8                | ±0.25     | −40°C to +125°C   | MSOP                | D1Q      | RM-10          |
| AD5426YRM-REEL                | 8                | ±0.25     | −40°C to +125°C   | MSOP                | D1Q      | RM-10          |
| AD5426YRM-REEL7               | 8                | ±0.25     | −40°C to +125°C   | MSOP                | D1Q      | RM-10          |
| AD5426YRMZ <sup>1</sup>       | 8                | ±0.25     | −40°C to +125°C   | MSOP                | D6W      | RM-10          |
| AD5426YRMZ-REEL <sup>1</sup>  | 8                | ±0.25     | −40°C to +125°C   | MSOP                | D6W      | RM-10          |
| AD5426YRMZ-REEL7 <sup>1</sup> | 8                | ±0.25     | −40°C to +125°C   | MSOP                | D6W      | RM-10          |
| AD5432YRM                     | 10               | ±0.5      | −40°C to +125°C   | MSOP                | D1R      | RM-10          |
| AD5432YRM-REEL                | 10               | ±0.5      | −40°C to +125°C   | MSOP                | D1R      | RM-10          |
| AD5432YRM-REEL7               | 10               | ±0.5      | −40°C to +125°C   | MSOP                | D1R      | RM-10          |
| AD5432YRMZ <sup>1</sup>       | 10               | ±0.5      | −40°C to +125°C   | MSOP                | D6V      | RM-10          |
| AD5432YRMZ-REEL <sup>1</sup>  | 10               | ±0.5      | −40°C to +125°C   | MSOP                | D6V      | RM-10          |
| AD5432YRMZ-REEL7 <sup>1</sup> | 10               | ±0.5      | −40°C to +125°C   | MSOP                | D6V      | RM-10          |
| AD5443YRM                     | 12               | ±1        | −40°C to +125°C   | MSOP                | D1S      | RM-10          |
| AD5443YRM-REEL                | 12               | ±1        | −40°C to +125°C   | MSOP                | D1S      | RM-10          |
| AD5443YRM-REEL7               | 12               | ±1        | −40°C to +125°C   | MSOP                | D1S      | RM-10          |
| AD5443YRMZ <sup>1</sup>       | 12               | ±1        | −40°C to +125°C   | MSOP                | D6U      | RM-10          |
| AD5443YRMZ-REEL <sup>1</sup>  | 12               | ±1        | −40°C to +125°C   | MSOP                | D6U      | RM-10          |
| AD5443YRMZ-REEL7 <sup>1</sup> | 12               | ±1        | −40°C to +125°C   | MSOP                | D6U      | RM-10          |
| EVAL-AD5426EB                 |                  |           |                   | Evaluation Kit      |          |                |
| EVAL-AD5432EB                 |                  |           |                   | Evaluation Kit      |          |                |
| EVAL-AD5443EB                 |                  |           |                   | Evaluation Kit      |          |                |

<sup>1</sup> Z = Pb-free part.